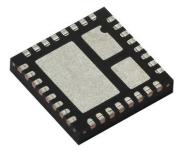
**Vishay Siliconix** 





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#### DESCRIPTION

The Vishay Siliconix SiC401A/B an advanced stand-alone synchronous buck regulator featuring integrated power MOSFETs, bootstrap switch, and a programmable LDO in a space-saving PowerPAK<sup>®</sup> MLP32-55G pin package.

The SiC401A/B is capable of operating with all ceramic solutions and switching frequencies up to 1 MHz. The programmable frequency, synchronous operation and selectable power-save allow operation at high efficiency across the full range of load current. The internal LDO may be used to supply 5 V for the gate drive circuits or it may be bypassed with an external 5 V for optimum efficiency and used to drive external n-channel MOSFETs or other loads. Additional features include cycle-by-cycle current limit, voltage soft-start, under voltage protection, programmable over current protection, soft shutdown and selectable power-save. The Vishay Siliconix SiC401A/B also provides an enable input and a power good output.

PRIMARY CHARACTERISTICS					
Input voltage range 3 V to 17 V					
Output voltage range <sup>a</sup> 0.6 V to V <sub>IN</sub> x 0.75					
Operating frequency	200 kHz to 1 MHz				
Continuous output current	15 A				
Peak efficiency	93 %				
Package	PowerPAK MLP32-55G				

Note

a. See "High Output Voltage Operation" section

#### FEATURES

- High efficiency > 93 %
- 15 A continuous output current capability
- Integrated bootstrap switch
- Programmable 200 mA LDO with bypass logic
- Temperature compensated current limit
- All ceramic solution enabled
- Pseudo fixed-frequency adaptive on-time control
- Programmable input UVLO threshold
- Independent enable pin for switcher and LDO
- Selectable ultra sonic power-save mode (SiC401A)
- Selectable power-save mode (SiC401B)
- Programmable soft-start and soft-shutdown
- 1 % internal reference voltage
- Power good output
- Over voltage and under voltage protections
- PowerCAD Simulation software available at <u>www.vishay.com/power-ics/powercad-list/</u>
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

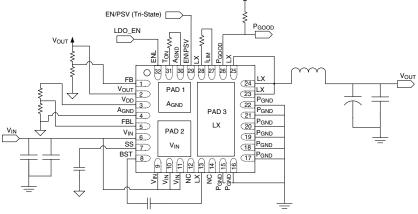
#### APPLICATIONS

- Notebook, desktop and server computers
- Digital HDTV and digital consumer applications
- Networking and telecommunication equipment
- Printers, DSL, and STB applications
- Embedded applications
- · Point of load power supplies



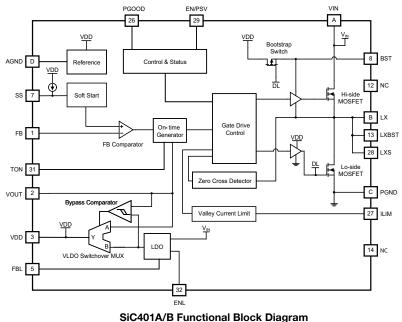
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### TYPICAL APPLICATION CIRCUIT AND PACKAGE OPTIONS



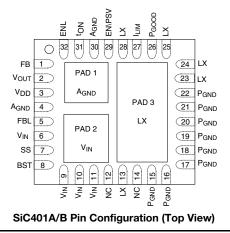
Typical Application Circuit for SiC401A/B (PowerPAK MLP32-55G)

#### FUNCTIONAL BLOCK DIAGRAM



 $\begin{aligned} A &= \text{connected to pins 6, 9-11, PAD 2} \\ B &= \text{connected to pins 23-25, PAD 3} \\ C &= \text{connected to pins 15-22} \\ D &= \text{connect to pins 4, 30, PAD 1} \end{aligned}$ 

**PIN CONFIGURATION** 



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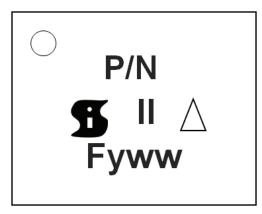


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PIN DESCRIPTI	ON				
PIN NUMBER	SYMBOL	DESCRIPTION			
1	FB	Feedback input for switching regulator used to program the output voltage - connect to an external resistor divider from $V_{OUT}$ to $A_{GND}$ .			
2	V <sub>OUT</sub>	Switcher output voltage sense pin - also the input to the internal switch-over between $V_{OUT}$ and $V_{LDO}$ . The voltage at this pin must be less than or equal to the voltage at the $V_{DD}$ pin.			
3	V <sub>DD</sub>	Bias supply for the IC - when using the internal LDO as a bias power supply, $V_{DD}$ is the LDO output. When using an external power supply as the bias for the IC, the LDO output should be disabled.			
4, 30, PAD 1	A <sub>GND</sub>	Analog ground			
5	FBL	Feedback input for the internal LDO - used to program the LDO output. Connect to an external resistor divider from $V_{DD}$ to $A_{GND}$ .			
6, 9 to 11, PAD 2	V <sub>IN</sub>	Input supply voltage			
7	SS	The soft start ramp will be programmed by an internal current source charging a capacitor on this pin.			
8	BST	Bootstrap pin - connect a capacitor of at least 100 nF from BST to LX to develop the floating supply for the high side gate drive.			
12, 14	NC	No connection			
13	LXBST	LX Boost - connect to the BST capacitor.			
23 to 25, PAD3	LX	Switching (phase) node			
15 to 22	P <sub>GND</sub>	Power ground			
26	P <sub>GOOD</sub>	Open-drain power good indicator - high impedance indicates power is good. An external pull-up resistor is required.			
27	I <sub>LIM</sub>	Current limit sense pin - used to program the current limit by connecting a resistor from $I_{LIM}$ to LXS.			
28	LXS	LX sense - connects to R <sub>ILIM</sub>			
29	29 EN/PSV				
31	t <sub>ON</sub>	On-time programming input - set the on-time by connecting through a resistor to $A_{GND}$			
32	ENL	Enable input for the LDO - connect ENL to $A_{GND}$ to disable the LDO. Drive with logic signal for logic control, or program the $V_{IN}$ UVLO with a resistor divider between $V_{IN}$ , ENL, and $A_{GND}$ .			

ORDERING INFORMATION		
PART NUMBER	PACKAGE	MARKING (LINE 1: P/N)
SiC401ACD-T1-GE3	PowerPAK MLP32-55G	SiC401A
SiC401BCD-T1-GE3	PowerPAK MLP32-55G	SiC401B
SiC401DB	Referen	ce board



Format:

Line 1: P/N

Line 2: Siliconix logo and lot code and ESD symbol Line 3: factory code and year code and work week code

3



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°C, unless otherwise noted)			
CONDITIONS	LIMITS	UNIT	
to P <sub>GND</sub>	-0.3 to 20		
to V <sub>DD</sub>	-0.4 max.		
to P <sub>GND</sub>	-0.3 to 20		
to P <sub>GND</sub>	-2 to 20		
to P <sub>GND</sub>	-0.3 to 6		
Reference to A <sub>GND</sub>	-0.3 to + (V <sub>DD</sub> + 0.3)	V	
to P <sub>GND</sub>	-0.3 to + (V <sub>DD</sub> - 1.5)		
to LX	-0.3 to 6		
to P <sub>GND</sub>	-0.3 to 25		
	-0.3 to V <sub>IN</sub>		
	-0.3 to 0.3		
	150	°C	
	-65 to +150	C	
IC section	50	°C/W	
Ambient temperature = 25 °C	3.4	W	
Ambient temperature = 100 °C	1.3	VV	
НВМ	2	– kV	
CDM	1	ĸv	
	CONDITIONS         to PGND         to VDD         to PGND         IC section         Ambient temperature = 100 °C         HBM	CONDITIONS         LIMITS           to P <sub>GND</sub> -0.3 to 20           to V <sub>DD</sub> -0.4 max.           to P <sub>GND</sub> -0.3 to 20           to P <sub>GND</sub> -0.3 to 6           Reference to A <sub>GND</sub> -0.3 to + (V <sub>DD</sub> + 0.3)           to P <sub>GND</sub> -0.3 to 4           to P <sub>GND</sub> -0.3 to 5           to LX         -0.3 to 6           to P <sub>GND</sub> -0.3 to 25           0.3 to V <sub>IN</sub> -0.3 to 0.3           0         -0.3 to 0.3           U         -0.3 to 0.3           0         -0.3 to 0.3           U         -0.5 to +150           IC section         50           Ambient temperature = 25 °C         3.4           Ambient temperature = 100 °C         1.3	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating/conditions for extended periods may affect device reliability.

RECOMMENDED OPERAT	ING CONDITIONS (al	l voltages refer	renced to GNE	0 = 0 V)	
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Input voltage	V <sub>IN</sub>	3	-	17	
V <sub>DD</sub> to P <sub>GND</sub>		3	-	5.5	V
Output voltage	V <sub>OUT</sub>	0.6	-	V <sub>IN</sub> x 0.75	
Temperature					
Ambient temperature			-40 to +85		°C



Vishay Siliconix

ELECTRICAL SPECIFICATIONS		TEST CONDITIONS UNLESS SPECIFIED			1	
PARAMETER	SYMBOL	$V_{IN} = 12 \text{ V}, V_{DD} = 5 \text{ V}, T_A = +25 \text{ °C for typ.}, -40 \text{ °C to +85 °C for min. and max.}, T_J = < 125 \text{ °C, typical application circuit}$	MIN.	TYP.	MAX.	UNIT
Input Power Supplies						
Input supply voltage	V <sub>IN</sub>		3	-	17	
V <sub>DD</sub>	V <sub>DD</sub>		3	-	5.5	
	N	Sensed at ENL pin, rising	2.4	2.6	2.95	
V <sub>IN</sub> UVLO threshold <sup>a</sup>	V <sub>UVLO</sub>	Sensed at ENL pin, falling	2.23	2.4	2.57	
V <sub>IN</sub> UVLO hysteresis	V <sub>UVLO, HYS</sub>		-	0.25	-	V
		Measured at V <sub>DD</sub> pin, rising	2.5	-	3	
V <sub>DD</sub> UVLO threshold	V <sub>UVLO</sub>	Measured at V <sub>DD</sub> pin, falling	2.4	-	2.9	
V <sub>DD</sub> UVLO hysteresis	V <sub>UVLO, HYS</sub>		-	0.2	-	
M suggli sugget	1	ENL, EN/PSV = 0 V, V <sub>IN</sub> = 17 V	-	10	20	
V <sub>IN</sub> supply current	I <sub>IN</sub>	Standby mode; ENL= V <sub>DD</sub> , EN/PSV = 0 V	-	130	-	μA
		ENL, EN/PSV = 0 V	-	190	300	1
		SiC401A, EN/PSV = $V_{DD}$ , no load (f <sub>SW</sub> = 25 kHz), V <sub>FB</sub> > 0.6 V <sup>b</sup>	-	0.3	-	
V <sub>DD</sub> supply current	I <sub>DD</sub>	SiC401B, EN/PSV = $V_{DD}$ , no load, $V_{FB} > 0.6 \text{ V}^{\text{b}}$	-	0.7	-	
		$V_{DD}$ = 5 V, f <sub>SW</sub> = 250 kHz, EN/PSV = floating, no load <sup>b</sup>	-	9	-	mA
		$V_{DD}$ = 3 V, f <sub>SW</sub> = 250 kHz, EN/PSV = floating, no load <sup>b</sup>	-	5.5	-	
FB on-time threshold		Static VIN and load	0.594	0.600	0.606	V
Frequency rende	£	Continuous mode operation	-	-	1000	
Frequency range	f <sub>SW</sub>	Minimum f <sub>SW</sub> , (SiC401A only)	-	25	-	kHz
Bootstrap switch resistance			-	10	-	Ω
Timing						
On-time	t <sub>ON</sub>	Continuous mode operation V <sub>IN</sub> = 12 V, V <sub>OUT</sub> = 5 V, f <sub>SW</sub> = 300 kHz, R <sub>ton</sub> = 133 k $\Omega$	999	1110	1220	
Minimum on-time <sup>b</sup>	t <sub>ON, min.</sub>		-	80	-	ns
Minimum off-time <sup>b</sup>	torr	$V_{DD} = 5 V$	-	250	-	
Minimum on-time	t <sub>OFF, min.</sub>	$V_{DD} = 3 V$	-	370	-	
Soft Start						
Soft start current <sup>b</sup>	I <sub>SS</sub>		-	3	-	μA
Soft start voltage <sup>b</sup>	V <sub>SS</sub>	When V <sub>OUT</sub> reaches regulation	-	1.5	-	V
Analog Inputs/Outputs						
V <sub>OUT</sub> input resistance	R <sub>O-IN</sub>		-	500	-	kΩ
Current Sense						
Zero-crossing detector threshold voltage	V <sub>Sense-th</sub>	LX-P <sub>GND</sub>	-3	-	+3	mV
Power Good						
Devues and three held	PG_V <sub>TH_UPPER</sub>	Upper limit, V <sub>FB</sub> > internal 600 mV reference	-	± 20	-	
Power good threshold	PG_V <sub>TH_LOWER</sub>	Lower limit, V <sub>FB</sub> < internal 600 mV reference	-	-10	-	%
Start-up delay time	_	V <sub>DD</sub> = 5 V, C <sub>SS</sub> = 10 nF	-	12	-	
(between PWM enable and P <sub>GOOD</sub> high)	PG_T <sub>d</sub>	V <sub>DD</sub> = 3 V, C <sub>SS</sub> = 10 nF	-	7	-	ms
Fault (noise-immunity) delay time <sup>b</sup>	PG_I <sub>CC</sub>		-	5	-	μs
Leakage current	PG_I <sub>LK</sub>		-	-	1	μA
Power good on-resistance	PG_R <sub>DS ON</sub>					Ω

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## **Vishay Siliconix**

<b>ELECTRICAL SPECIFICATIONS</b>						
PARAMETER	SYMBOL	$\label{eq:spectral_spectrum} \begin{array}{ c c c c c } \hline \textbf{TEST CONDITIONS UNLESS SPECIFIED} \\ V_{IN} = 12 \ V, \ V_{DD} = 5 \ V, \ T_A = +25 \ ^\circ C \ \text{for typ.}, \\ -40 \ ^\circ C \ \text{to} +85 \ ^\circ C \ \text{for min. and max.}, \\ T_J = < 125 \ ^\circ C, \ \text{typical application circuit} \end{array}$	MIN.	TYP.	MAX.	UNIT
Fault Protection						
Valley current limit	1	$V_{DD} = 5 \text{ V}, \text{ R}_{ILIM} = 3945, \text{ T}_{J} = 0 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	12.75	15	17.25	А
valley current limit	I <sub>LIM</sub>	V <sub>DD</sub> = 3.3 V, R <sub>ILIM</sub> = 3945	-	13.5	-	A
I <sub>LIM</sub> source current			-	10	-	μA
I <sub>LIM</sub> comparator offset voltage	V <sub>ILM-LK</sub>	With respect to A <sub>GND</sub>	-10	0	+10	mV
Output under-voltage fault	V <sub>OUV_Fault</sub>	V <sub>FB</sub> with respect to Internal 600 mV reference, 8 consecutive clocks	-	-25	-	
Smart power-save protection threshold voltage <sup>b</sup>	P <sub>Save_VTH</sub>	$V_{FB}$ with respect to internal 600 mV	-	+10	-	%
Over voltage protection threshold		V <sub>FB</sub> with respect to internal 600 mV	-	+20	-	
Over voltage fault delay <sup>b</sup>	t <sub>OV-Delay</sub>		-	5	-	μs
Over temperature shutdown <sup>b</sup>	T <sub>Shut</sub>	10 °C hysteresis	-	150	-	°C
Logic Inputs/Outputs						
Logic input high voltage	V <sub>IH</sub>		1	-	-	
Logic input low voltage	V <sub>IL</sub>		-	-	0.4	
EN/PSV input for P-save operation <sup>b</sup>		$V_{DD} = 5 V$	2.2	-	5	v
EN/PSV input for forced continuous operation <sup>b</sup>			1	-	2	
EN/PSV input for disabling switcher			0	-	0.4	
EN/PSV input bias current	I <sub>EN</sub>		-10	-	+10	
ENL input bias current	I <sub>ENL</sub>		-	8	15	μA
FBL, FB input bias current	$FBL_{LK}$		-1	-	+1	
Linear Dropout Regulator						
FBL <sup>b</sup>	V <sub>LDO ACC</sub>		-	0.75	-	V
		Short-circuit protection, $V_{IN} = 12 \text{ V}, V_{DD} < 0.75 \text{ V}$	-	65	-	
LDO current limit	LDO_I <sub>LIM</sub>	Start-up and foldback, $V_{IN}$ = 12 V, 0.75 $<$ $V_{DD}$ $<$ 90 % of final $V_{DD}$ value	-	115	-	mA
		$\label{eq:operating current limit, V_{IN} = 12 V,} \\ V_{DD} > 90 \ \% \ of \ final \ V_{DD} \ value$	135	200	-	
$V_{LDO}$ to $V_{OUT}$ switch-over threshold <sup>d</sup>	V <sub>LDO-BPS</sub>		-130	-	+130	m)/
$V_{LDO}$ to $V_{OUT}$ non-switch-over threshold <sup>d</sup>	V <sub>LDO-NBPS</sub>		-500	-	+500	mV
V <sub>LDO</sub> to V <sub>OUT</sub> switch-over resistance	R <sub>LDO</sub>	V <sub>OUT</sub> = 5 V	-	2	-	Ω
LDO drop out voltage <sup>e</sup>		From $V_{IN}$ to $V_{DD}$ , $V_{DD} = +5 \text{ V}$ , $I_{VLDO} = 100 \text{ mA}$	-	1.2	-	v

Notes

a. VIN UVLO is programmable using a resistor divider from VIN to ENL to AGND. The ENL voltage is compared to an internal reference

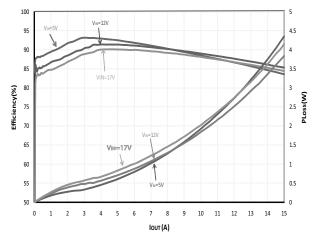
b. Typical value measured on standard evaluation board

c. SiC401A/B has first order temperature compensation for over current. Results vary based upon the PCB thermal layout

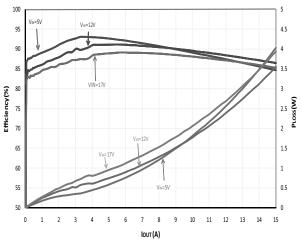
d. The switch-over threshold is the maximum voltage differential between the  $V_{LDO}$  and  $V_{OUT}$  pins which ensures that  $V_{LDO}$  will internally switch-over to  $V_{OUT}$ . The non-switch-over threshold is the minimum voltage differential between the  $V_{LDO}$  and  $V_{OUT}$  pins which ensures that  $V_{LDO}$  will not switch-over to  $V_{OUT}$ .

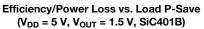
e. The LDO drop out voltage is the voltage at which the LDO output drops 2 % below the nominal regulation point

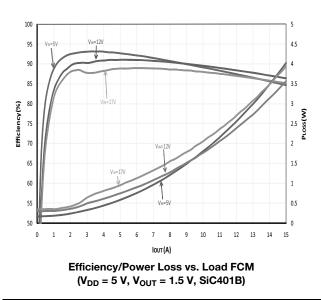


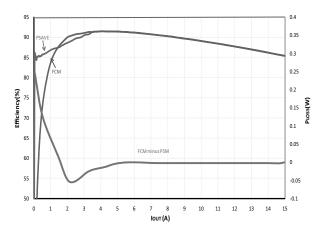


Efficiency/Power Loss vs. Load P-Save (V<sub>DD</sub> = 3.3 V, V<sub>OUT</sub> = 1.5 V, SiC401B)

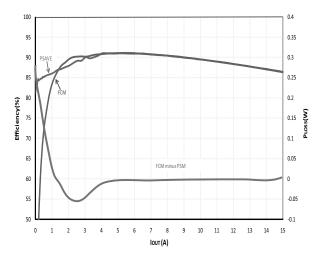




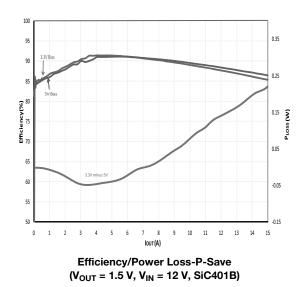




Efficiency/Power Loss-P-Save vs. FCM ( $V_{DD}$  = 3.3 V,  $V_{OUT}$  = 1.5 V,  $V_{IN}$  = 12 V, SiC401B)



Efficiency/Power Loss-P-Save vs. FCM ( $V_{DD} = 5 V$ ,  $V_{OUT} = 1.5 V$ ,  $V_{IN} = 12 V$ , SiC401B)



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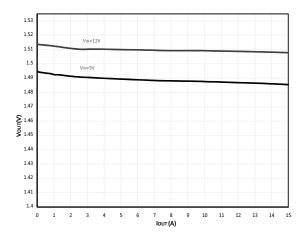
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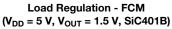
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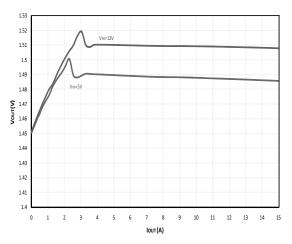
# SiC401A, SiC401BCD

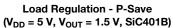
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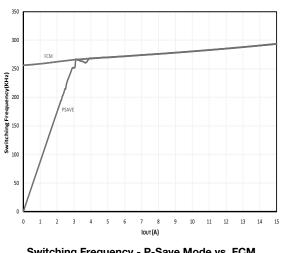


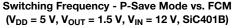


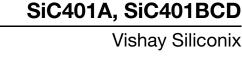


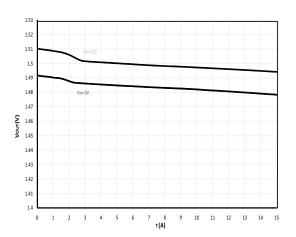




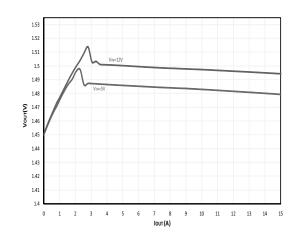




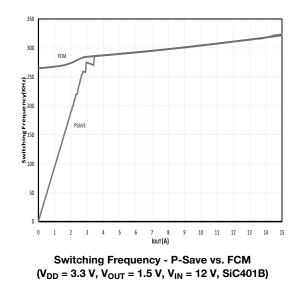




Load Regulation - FCM  $(V_{DD} = 3.3 \text{ V}, V_{OUT} = 1.5 \text{ V}, \text{SiC401B})$ 



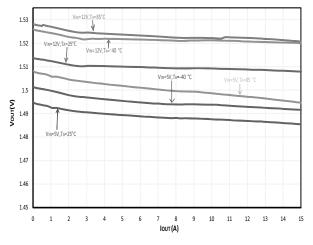
Load Regulation - P-Save  $(V_{DD} = 3.3 \text{ V}, V_{OUT} = 1.5 \text{ V}, \text{SiC401B})$ 



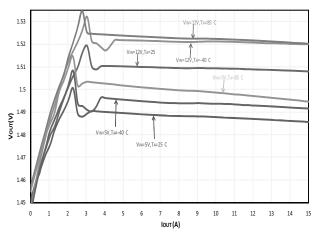
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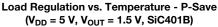
8 estions contact: powerictecheuppo Document Number: 63835

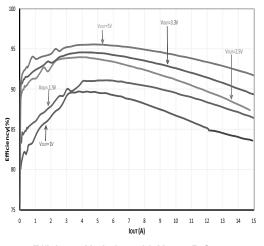


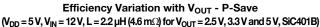


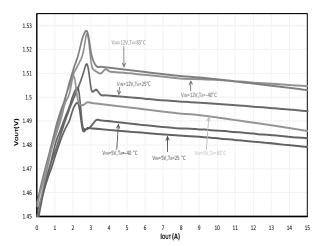
Load Regulation vs. Temperature - FCM ( $V_{DD}$  = 5 V,  $V_{OU}$ T = 1.5 V, SiC401B)



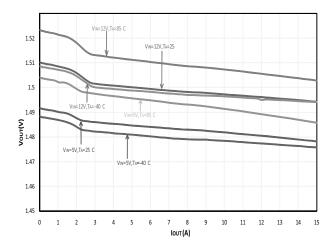




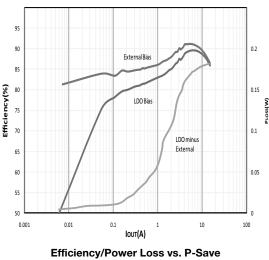




Load Regulation vs. Temperature - P-Save  $(V_{DD} = 3.3 V, V_{OUT} = 1.5 V, SiC401B)$ 



Load Regulation vs. Temperature - FCM (V<sub>DD</sub> = 3.3 V, V<sub>OUT</sub> = 1.5 V, SiC401B)



 $(V_{OUT} = 1.5 \text{ V}, V_{IN} = 12 \text{ V}, \text{SiC401B})$ 

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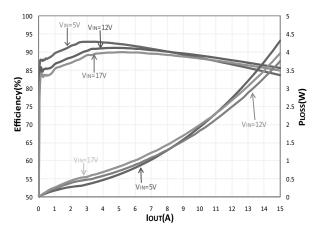
9 For technical questions, contact: <u>powerictechsupport@vishay.com</u> Document Number: 63835

SiC401A, SiC401BCD

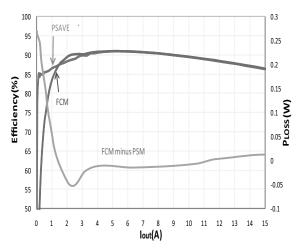
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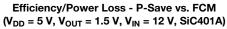
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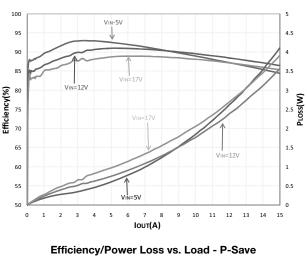




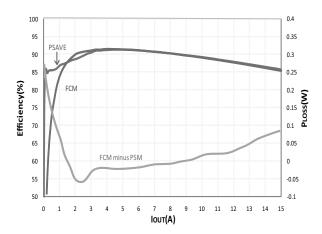
Efficiency/Power Loss vs. Load - P-Save (V<sub>DD</sub> = 3.3 V, V<sub>OUT</sub> = 1.5 V, SiC401A)



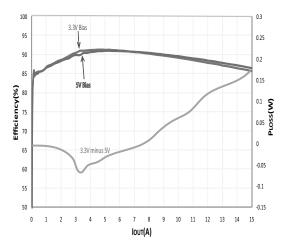




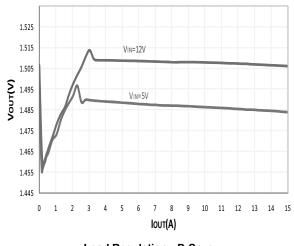
(V<sub>DD</sub> = 5 V, V<sub>OUT</sub> = 1.5 V, SiC401A)



Efficiency/Power Loss - P-Save vs. FCM ( $V_{DD}$  = 3.3 V,  $V_{OUT}$  = 1.5 V,  $V_{IN}$  = 12 V, SiC401A)



Efficiency/Power Loss - P-Save (V<sub>OUT</sub> = 1.5 V, V<sub>IN</sub> = 12 V, SiC401A)



Load Regulation - P-Save  $(V_{DD} = 5 V, V_{OUT} = 1.5 V, SiC401A)$ 

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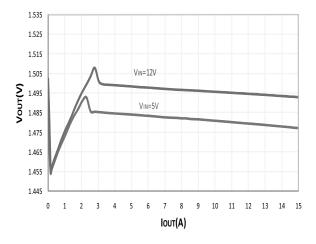
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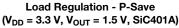
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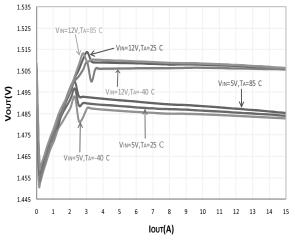
## SiC401A, SiC401BCD

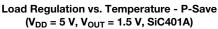
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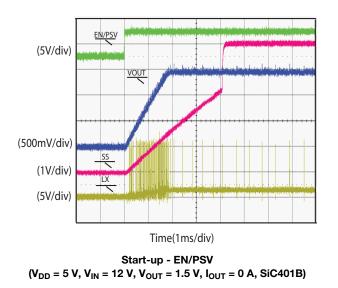


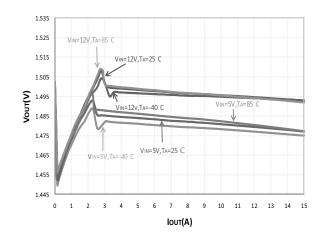




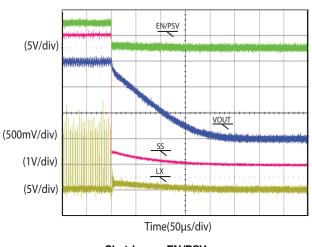


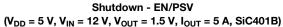






Load Regulation vs. Temperature - P-Save  $(V_{DD} = 5 V, V_{OUT} = 1.5 V, SiC401A)$ 





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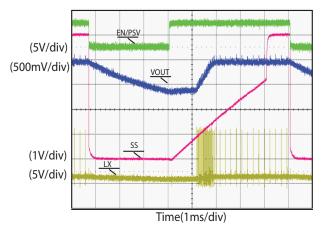
## SiC401A, SiC401BCD

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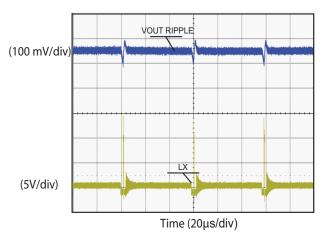


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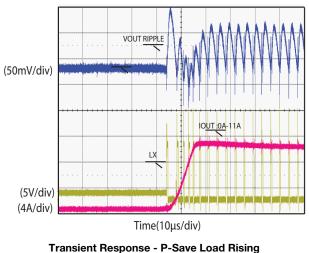
### **ELECTRICAL CHARACTERISTICS**



 $\label{eq:start-up} \begin{array}{l} \mbox{Start-up (Pre-Bias) - EN/PSV} \\ \mbox{(V_{DD} = 5 V, V_{IN} = 12 V, V_{OUT} = 1.5 V, I_{OUT} = 0 A, SiC401B)} \end{array}$ 



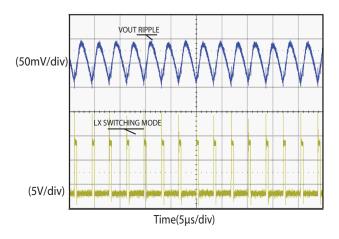
 $\label{eq:vdv} \begin{array}{l} Power-Save \mbox{ Mode} \\ (V_{DD}=5 \mbox{ V}, \mbox{ V}_{IN}=12 \mbox{ V}, \mbox{ V}_{OUT}=1.5 \mbox{ V}, \mbox{ I}_{OUT}=0 \mbox{ A}, \mbox{ SiC401A}) \end{array}$ 



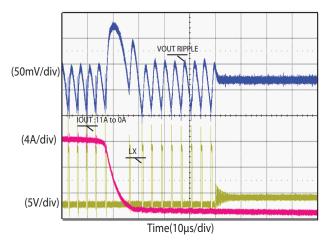
 $(V_{DD} = 5 V, V_{IN} = 12 V, V_{OUT} = 1.5 V, I_{OUT} = 0 A to 11 A, SiC401B, dl/dt = 1 A/\mu s)$ 

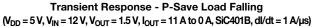
(50mV/div)

 $\label{eq:VDD} \begin{array}{l} Power-Save \mbox{ Mode} \\ (\mbox{V}_{DD}=5\mbox{ V},\mbox{ V}_{IN}=12\mbox{ V},\mbox{ V}_{OUT}=1.5\mbox{ V},\mbox{ I}_{OUT}=0\mbox{ A},\mbox{ SiC401B}) \end{array}$ 



Forced Continuous Mode ( $V_{DD}$  = 5 V,  $V_{IN}$  = 12 V,  $V_{OUT}$  = 1.5 V,  $I_{OUT}$  = 15 A, SiC401B)





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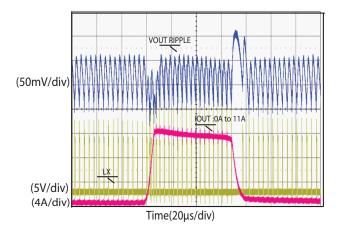
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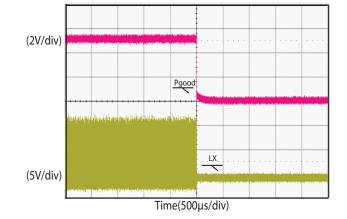
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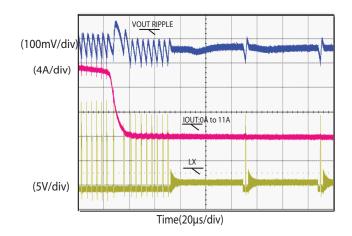
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### **ELECTRICAL CHARACTERISTICS**



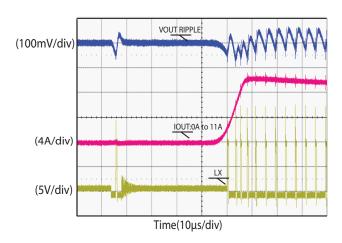


Over Temperature Shutdown at 133.4  $^\circ C$  (V<sub>IN</sub> = 12 V, V<sub>OUT</sub> = 1.5 V, I<sub>OUT</sub> = 0 A, LDO Mode, SiC401B)

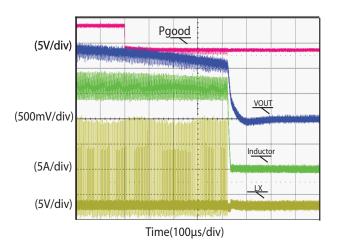


 $\label{eq:transient} \begin{array}{l} Transient \ Response \ - \ P-Save \ Load \ Falling \\ (V_{DD}=5 \ V, \ V_{IN}=12 \ V, \ V_{OUT}=1.5 \ V, \ I_{OUT}=11 \ A \ to \ 0 \ A, \ SiC401A, \ dl/dt=1 \ A/\mu s) \end{array}$ 

 $\label{eq:VDD} Transient \ Response \ - \ FCM \\ (V_{DD} = 5 \ V, \ V_{IN} = 12 \ V, \ V_{OUT} = 1.5 \ V, \ I_{OUT} = 0 \ A \ to \ 11 \ A, \ SiC401B, \ dl/dt = 1 \ A/\mu s) \\$ 



Transient Response - P-Save Load Rising ( $V_{DD}$  = 5 V,  $V_{IN}$  = 12 V,  $V_{OUT}$  = 1.5 V,  $I_{OUT}$  = 0 A to 11 A, SiC401A, dl/dt = 1 A/µs)



Over Current Protection-Under Voltage Prodection ( $V_{DD} = 5 V, V_{IN} = 12 V, V_{OUT} = 1.5 V, SiC401B$ )

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### **OPERATIONAL DESCRIPTION**

#### **Device Overview**

The SiC401A/B is a step down synchronous DC/DC buck converter with integrated power MOSFETs and a 200 mA capable programmable LDO. The device is capable of 15 A operation at very high efficiency. A space saving 5 mm x 5 mm 32-pin package is used. The programmable operating frequency of up to 1 MHz enables optimizing the configuration for PCB area and efficiency.

The buck controller uses a pseudo-fixed frequency adaptive on-time control. This control method allows fast transient response which permits the use of smaller output capacitors.

#### **Input Voltage Requirements**

The SiC401A/B requires two input supplies for normal operation:  $V_{IN}$  and  $V_{DD}$ .  $V_{IN}$  operates over a wide range from 3 V to 17 V.  $V_{DD}$  requires a 3 V to 5.5 V supply input that can be an external source or the internal LDO configured to supply 3 V to 5.5 V from  $V_{IN}$ .

#### **Power Up Sequence**

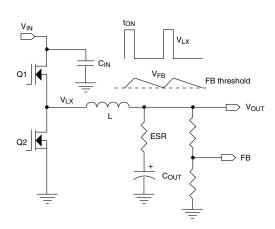
When the SiC401A/B uses an external power source at the  $V_{DD}$  pin, the switching regulator initiates the start up when  $V_{IN}$ ,  $V_{DD}$ , and EN/PSV are above their respective thresholds. When EN/PSV is at logic high,  $V_{DD}$  needs to be applied after  $V_{IN}$  rises. It is also recommended to use a 10  $\Omega$  resistor between an external power source and the  $V_{DD}$  pin. To start up by using the EN/PSV pin when both  $V_{DD}$  and  $V_{IN}$  are above their respective thresholds, apply EN/PSV to enable the start-up process. For SiC401A/B in self-biased mode, refer to the LDO section for a full description.

#### Shutdown

The SiC401A/B can be shut-down by pulling either V<sub>DD</sub> or EN/PSV below its threshold. When using an external power source, it is recommended that the V<sub>DD</sub> voltage ramps down before the V<sub>IN</sub> voltage. When V<sub>DD</sub> is active and EN/PSV at logic low, the output voltage discharges into the V<sub>OUT</sub> pin through an internal FET.

#### **Pseudo-Fixed Frequency Adaptive On-Time Control**

The PWM control method used by the SiC401A/B is pseudo- fixed frequency, adaptive on-time, as shown in Fig. 1. The ripple voltage generated at the output capacitor ESR is used as a PWM ramp signal. This ripple is used to trigger the on-time of the controller.



#### Fig. 1 - Output Ripple and PWM Control Method

The adaptive on-time is determined by an internal one- shot timer. When the one-shot is triggered by the output ripple, the device sends a single on-time pulse to the high side MOSFET. The pulse period is determined by  $V_{OUT}$  and  $V_{IN}$ ; the period is proportional to output voltage and inversely proportional to input voltage. With this adaptive on-time arrangement, the device automatically anticipates the on-time needed to regulate  $V_{OUT}$  for the present  $V_{IN}$  condition and at the selected frequency.

The advantages of adaptive on-time control are:

- Predictable operating frequency compared to other variable frequency methods.
- Reduced component count by eliminating the error amplifier and compensation components.
- Reduced component count by removing the need to sense and control inductor current.
- Fast transient response the response time is controlled by a fast comparator instead of a typically slow error amplifier.
- Reduced output capacitance due to fast transient response.

#### **One-Shot Timer and Operating Frequency**

The one-shot timer operates as shown in Fig. 2. The FB comparator output goes high when  $V_{FB}$  is less than the internal 600 mV reference. This feeds into the gate drive and turns on the high side MOSFET, and also starts the one-shot timer. The one-shot timer uses an internal comparator and a capacitor. One comparator input is connected to  $V_{OUT}$ , the other input is connected to the capacitor. When the on-time begins, the internal capacitor charges from zero volts through a current which is proportional to  $V_{IN}$ . When the capacitor voltage reaches  $V_{OUT}$ , the on-time is completed and the high side MOSFET turns off.

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Note that this control method regulates the valley of the output ripple voltage, not the DC value. The DC output

voltage V<sub>OUT</sub> is offset by the output ripple according to the

 $V_{OUT} = 0.6 \text{ x} \left( 1 + \frac{R_1}{R_2} \right) + \left( \frac{V_{RIPPLE}}{2} \right)$ 

When a large capacitor is placed in parallel with R1 (C<sub>TOP</sub>)

 $V_{OUT} = 0.6 x \left(1 + \frac{R_1}{R_2}\right) + \left(\frac{V_{RIPPLE}}{2}\right) x \sqrt{\frac{1 + (R_1 \omega C_{TOP})^2}{1 + \left(\frac{R_2 x R_1}{R_2 + R_1} \omega C_{TOP}\right)^2}}$ 

The EN/PSV input is used to enable or disable the switching regulator. When EN/PSV is low (grounded), the switching regulator is off and in its lowest power state. When off, the output of the switching regulator soft-discharges the output

into a 15  $\Omega$  internal resistor via the V<sub>OUT</sub> pin. When EN/PSV

is allowed to float, the pin voltage will float to 33 % of the

voltage at V<sub>DD</sub>. The switching regulator turns on with

power-save disabled and all switching is in forced

When EN/PSV is high (above 44 % of the voltage at  $V_{DD}$ ), the switching regulator turns on with power-save enabled. The SiC401A/B P-Save operation reduces the switching frequency according to the load for increased efficiency at

The SiC401A/B operates the switcher in FCM (forced continuous mode) by floating the EN/PSV pin (see Fig. 4). In this mode one of the power MOSFETs is always on, with no

intentional dead time other than to avoid cross-conduction.

This feature results in uniform frequency across the full load range with the trade-off being poor efficiency at light loads due to the high frequency switching of the MOSFETs. DH is gate signal to drive upper MOSFET. DL is lower gate signal

V<sub>OUT</sub> is shown by the following equation.

Enable and Power-Save Inputs

continuous mode.

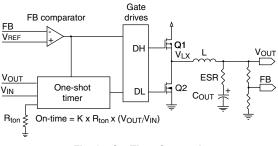
light load conditions.

to drive lower MOSFET.

**Forced Continuous Mode Operation** 

following equation.

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Fig. 2 - On-Time Generation

This method automatically produces an on-time that is proportional to  $V_{OUT}$  and inversely proportional to  $V_{IN}$ . Under steady-state conditions, the switching frequency can be determined from the on-time by the following equation.

$$f_{SW} = \frac{V_{OUT}}{t_{ON} \times V_{IN}}$$

The SiC401A/B uses an external resistor to set the on-time which indirectly sets the frequency. The on-time can be programmed to provide operating frequency up to 1 MHz using a resistor between the  $t_{\rm ON}$  pin and ground. The resistor value is selected by the following equation.

$$R_{ton} = \frac{k}{25 \text{ pF x fsw}}$$

The constant, k, equals 1, when  $V_{DD}$  is greater than 3.6 V. If  $V_{DD}$  is less than 3.6 V and  $V_{IN}$  is greater than (V\_{DD} -1.75) x 10, k is shown by the following equation.

$$k = \frac{(V_{DD} - 1.75) \times 10}{V_{IN}}$$

The maximum  $\mathrm{R}_{\mathrm{tON}}$  value allowed is shown by the following equation.

$$R_{ton\_MAX} = \frac{V_{IN\_MIN}}{15 \ \mu A}$$

#### V<sub>OUT</sub> Voltage Selection

The switcher output voltage is regulated by comparing  $V_{OUT}$  as seen through a resistor divider at the FB pin to the internal 600 mV reference voltage, see Fig. 3.

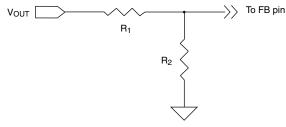
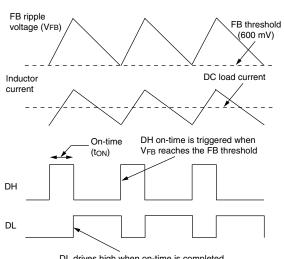


Fig. 3 - Output Voltage Selection

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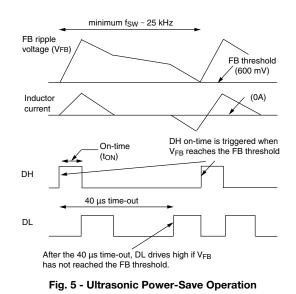
DL drives high when on-time is completed. DL remains high until  $V_{FB}$  falls to the FB threshold.

#### Fig. 4 - Forced Continuous Mode Operation

#### Ultrasonic Power-Save Operation (SiC401A)

The SiC401A provides ultrasonic power-save operation at light loads, with the minimum operating frequency fixed at slightly under 25 kHz. This is accomplished by using an internal timer that monitors the time between consecutive high side gate pulses. If the time exceeds 40  $\mu$ s, DL drives high to turn the low side MOSFET on. This draws current from V<sub>OUT</sub> through the inductor, forcing both V<sub>OUT</sub> and V<sub>FB</sub> to fall. When V<sub>FB</sub> drops to the 600 mV threshold, the next DH (the drive signal for the high side FET) on-time is triggered. After the on-time is completed, the high side MOSFET is turned off and the low side MOSFET turns on. The low side MOSFET remains on until the inductor current ramps down to zero, at which point the low side MOSFET is turned off.

Because the on-times are forced to occur at intervals no greater than 40  $\mu$ s, the frequency will not fall far below 25 kHz. Fig. 5 shows ultrasonic power-save operation.

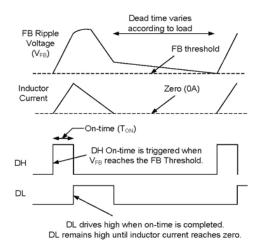


#### Power-Save Operation (SiC401B)

The SiC401B provides power-save operation at light loads with no minimum operating frequency. With power-save enabled, the internal zero crossing comparator monitors the inductor current via the voltage across the low side MOSFET during the off-time. If the inductor current falls to zero for eight consecutive switching cycles, the controller enters MOSFET on each subsequent cycle provided that the power-save operation. It will turn off the low side MOSFET on each subsequent cycle provided that the current crosses zero. At this time both MOSFETs remain off until V<sub>FB</sub> drops to the 600 mV threshold. Because the MOSFETs are off, the load is supplied by the output capacitor.

If the inductor current does not reach zero on any switching cycle, the controller immediately exits power-save and returns to forced continuous mode.

Fig. 6 shows power-save operation at light loads.



#### Fig. 6 - Power-Save Mode

#### **Smart Power-Save Protection**

Active loads may leak current from a higher voltage into the switcher output. Under light load conditions with power-save enabled, this can force  $V_{OUT}$  to slowly rise and reach the over voltage threshold, resulting in a hard shut-down. Smart power-save prevents this condition. When the FB voltage exceeds 10 % above nominal, the device immediately disables power-save, and DL drives high to turn on the low side MOSFET. This draws current from  $V_{OUT}$  through the inductor and causes  $V_{OUT}$  to fall. When  $V_{FB}$  drops back to the 600 mV trip point, a normal  $t_{ON}$  switching cycle begins. This method prevents a hard OVP shut-down and also cycles energy from  $V_{OUT}$  back to  $V_{IN}$ . It also minimizes operating power by avoiding forced conduction mode operation. Fig. 7 shows typical waveforms for the Smart Power Save feature.

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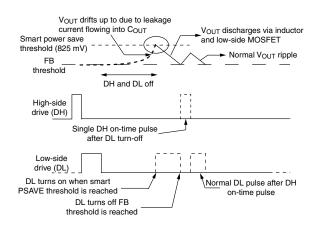


Fig. 7 - Smart Power-Save

#### SmartDrive<sup>™</sup>

For each DH pulse, the DH driver initially turns on the high side MOSFET at a lower speed, allowing a softer, smooth turn-off of the low side diode. Once the diode is off and the LX voltage has risen 0.5 V above PGND, the SmartDrive circuit automatically drives the high side MOSFET on at a rapid rate. This technique reduces switching losses while maintaining high efficiency and also avoids the need for snubbers for the power MOSFETs.

#### **Current Limit Protection**

The device features programmable current limiting, which is accomplished by using the R<sub>DS-ON</sub> of the lower MOSFET for current sensing. The current limit is set by RILIM resistor. The  $R_{\text{ILIM}}$  resistor connects from the  $I_{\text{LIM}}$  pin to the LXS pin which is also the drain of the low side MOSFET. When the low side MOSFET is on, an internal ~ 10  $\mu$ A current flows from the I<sub>LIM</sub> pin and through the RILIM resistor, creating a voltage drop across the resistor. While the low side MOSFET is on, the inductor current flows through it and creates a voltage across the R<sub>DS-ON</sub>. The voltage across the MOSFET is negative with respect to ground. If this MOSFET voltage drop exceeds the voltage across RILIM, the voltage at the ILIM pin will be negative and current limit will activate. The current limit then keeps the low side MOSFET on and will not allow another high side on-time, until the current in the low side MOSFET reduces enough to bring the ILIM voltage back up to zero. This method regulates the inductor valley current at the level shown by ILIM in Fig. 8.

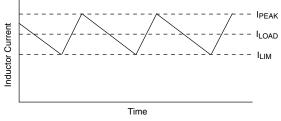


Fig. 8 - Valley Current Limit

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Setting the valley current limit to 15 A results in a peak inductor current of 15 A plus peak ripple current. In this situation, the average (load) current through the inductor is 15 A plus one-half the peak-to-peak ripple current.

The internal 10 uA current source is temperature compensated at 4100 ppm in order to provide tracking with the R<sub>DS-ON</sub>.

The R<sub>ILIM</sub> value is calculated by the following equation.

 $R_{ILIM} = 263 \times I_{LIM} \times [0.112 \times (5 \text{ V} - \text{V}_{DD}) + 1]$ 

When selecting a value for R<sub>IIIM</sub> be sure not to exceed the absolute maximum voltage value for the ILIM pin. Note that because the low side MOSFET with low R<sub>DS-ON</sub> is used for current sensing, the PCB layout, solder connections, and PCB connection to the LX node must be done carefully to obtain good results. RILIM should be connected directly to LXS (pin 28).

#### Soft-Start of PWM Regulator

SiC401A/B has a programmable soft-start time that is controlled by an external capacitor at the SS pin. After the controller meets both UVLO and EN/PSV thresholds, the controller has an internal current source of 3 µA flowing through the SS pin to charge the capacitor. During the start up process (Fig. 9), 50 % of the voltage at the SS pin is used as the reference for the FB comparator. The PWM comparator issues an on-time pulse when the voltage at the FB pin is less than 40 % of the SS pin. As a result, the output voltage follows the SS voltage. The output voltage reaches and maintains regulation when the soft start voltage is  $\geq$  1.5 V. The time between the first LX pulse and V<sub>OUT</sub> reaching regulation is the soft-start time (t<sub>SS</sub>). The calculation for the soft-start time is shown by the following equation.

$$t_{SS} = C_{SS} \times \frac{1.5 \text{ V}}{3 \mu \text{A}}$$

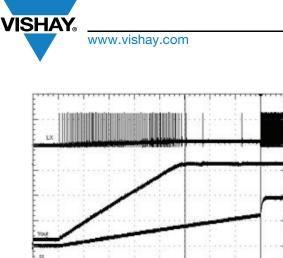
The voltage at the SS pin continues to ramp up and eventually equals 64 % of V<sub>DD</sub>. After the soft start completes, the FB pin voltage is compared to an internal reference of 0.6 V. The delay time between the V<sub>OUT</sub> regulation point and P<sub>GOOD</sub> going high is shown by the following equation.

$$t_{PGOOD-DELAY} = \frac{C_{SS} \times (0.64 \times V_{DD} - 1.5 \text{ V})}{3 \,\mu\text{A}}$$

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#### Pre-Bias Start-Up

The SiC401A/B can start up normally even when there is an existing output voltage present. The soft start time is still the same as normal start up (when the output voltage starts from zero). The output voltage starts to ramp up when 40 % of the voltage at SS pin meets the existing FB voltage level. Pre-bias startup is achieved by turning off the lower gate when the inductor current falls below zero. This method prevents the output voltage from discharging.

#### **Power Good Output**

The  $P_{GOOD}$  (power good) output is an open-drain output which requires a pull-up resistor. When the voltage at the FB pin is 10 % below the nominal voltage,  $P_{GOOD}$  is pulled low. It is held low until the output voltage returns above -8 % of nominal.

 $\mathsf{P}_{GOOD}$  will transition low if the  $\mathsf{V}_{FB}$  pin exceeds +20 % of nominal, which is also the over voltage shutdown threshold.  $\mathsf{P}_{GOOD}$  also pulls low if the EN/PSV pin is low when  $\mathsf{V}_{DD}$  is present.

#### **Output Over Voltage Protection**

Over voltage protection becomes active as soon as the device is enabled. The threshold is set at 600 mV +20 % (720 mV). When V<sub>FB</sub> exceeds the OVP threshold, DL latches high and the low side MOSFET is turned on. DL remains high and the controller remains off, until the EN/PSV input is toggled or V<sub>DD</sub> is cycled. There is a 5  $\mu$ s delay built into the OVP detector to prevent false transitions. P<sub>GOOD</sub> is also low after an OVP event.

#### **Output Under Voltage Protection**

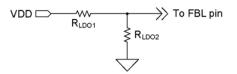
When  $V_{FB}$  falls 25 % below its nominal voltage (falls to 450 mV) for eight consecutive clock cycles, the switcher is shut off and the DH and DL drives are pulled low to tristate the MOSFETs. The controller stays off until EN/PSV is toggled or  $V_{DD}$  is cycled.

## V<sub>DD</sub> UVLO, and POR

UVLO (Under Voltage Lock-Out) circuitry inhibits switching and tri-states the DH/DL drivers until  $V_{DD}$  rises above 3 V. An internal POR (Power-On Reset) occurs when  $V_{DD}$  exceeds 3 V, which resets the fault latch and a soft-start counter cycle begins which prepares for soft-start. The SiC401A/B then begins a soft-start cycle. The PWM will shut off if  $V_{DD}$  falls below 2.4 V.

#### LDO Regulator

SiC401A/B has an option to bias the switcher by using an internal LDO from V<sub>IN</sub>. The LDO output is connected to V<sub>DD</sub> internally. The output of the LDO is programmable by using external resistors from the V<sub>DD</sub> pin to A<sub>GND</sub> (see Fig. 10). The feedback pin (FBL) for the LDO is regulated to 750 mV.



## Fig. 10 - LDO Output Voltage Selection

The LDO output voltage is set by the following equation.

$$V_{LDO} = 750 \text{ mV x} \left(1 + \frac{R_{LDO1}}{R_{LDO2}}\right)$$

A minimum capacitance of 1  $\mu$ F referenced to A<sub>GND</sub> is normally required at the output of the LDO for stability.

Note that if the LDO voltage is set lower than 4.5 V, the minimum output capacitance for the LDO is 10  $\mu F.$ 

#### LDO ENL Functions

The ENL input is used to enable/disable the internal LDO. When ENL is a logic low, the LDO is off. When ENL is above the  $V_{\rm IN}$  UVLO threshold, the LDO is enabled and the switcher is also enabled if the EN/PSV and  $V_{\rm DD}$  are above their threshold. The table below summarizes the function of ENL and EN/PSV pins.

EN/PSV	ENL	LDO	SWITCHER
Disabled	Low, < 0.4 V	Off	Off
Enabled	Low, < 0.4 V	Off	On
Disabled	1 V < High < 2.6 V	On	Off
Enabled	1 V < High < 2.6 V	On	Off
Disabled	High, > 2.6 V	On	Off
Enabled	High, > 2.6 V	On	On

The ENL pin also acts as the switcher under voltage lockout for the V<sub>IN</sub> supply. When SiC401A/B is self-biased from the LDO and runs from the V<sub>IN</sub> power source only, the V<sub>IN</sub> UVLO feature can be used to prevent false UV faults for the PWM output by programming with a resistor divider at the V<sub>IN</sub>, ENL and A<sub>GND</sub> pins. When SiC401A/B has an external bias voltage at V<sub>DD</sub> and the ENL pin is used to program the V<sub>IN</sub>

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UVLO feature, the voltage at FBL needs to be higher than 750 mV to force the LDO off.

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Timing is important when driving ENL with logic and not implementing V<sub>IN</sub> UVLO. The ENL pin must transition from high to low within 2 switching cycles to avoid the PWM output turning off. If ENL goes below the V<sub>IN</sub> UVLO threshold and stays above 1 V, then the switcher will turn off but the LDO will remain on.

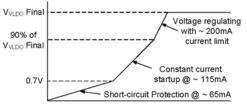
#### LDO Start-Up

Before start-up, the LDO checks the status of the following signals to ensure proper operation can be maintained.

- 1. ENL pin
- 2. V<sub>LDO</sub> output

When the ENL pin is high and  $V_{\mbox{\scriptsize IN}}$  is above the UVLO point, the LDO will begin start-up. During the initial phase, when the V<sub>DD</sub> voltage (which is the LDO output voltage) is less than 0.75 V, the LDO initiates a current-limited start-up (typically 65 mA) to charge the output capacitors while protecting from a short circuit event. When  $V_{DD}$  is greater than 0.75 V but still less than 90 % of its final value (as sensed at the FBL pin), the LDO current limit is increased to ~115 mA. When  $V_{DD}$  has reached 90 % of the final value (as sensed at the FBL pin), the LDO current limit is increased to ~200 mA and the LDO output is quickly driven to the nominal value by the internal LDO regulator. It is recommended that during LDO start-up to hold the PWM switching off until the LDO has reached 90 % of the final value. This prevents overloading the current-limited LDO output during the LDO start-up.

Due to the initial current limitations on the LDO during power up (Fig. 11), any external load attached to the  $V_{DD}$  pin must be limited to less than the start up current before the LDO has reached 90 % of its final regulation value.





#### LDO Switch-Over Operation

The SiC401A/B includes a switch-over function for the LDO. The switch-over function is designed to increase efficiency by using the more efficient DC/DC converter to power the LDO output, avoiding the less efficient LDO regulator when possible. The switch-over function connects the V<sub>DD</sub> pin directly to the V<sub>OUT</sub> pin using an internal switch. When the switch-over is complete the LDO is turned off, which results in a power savings and maximizes efficiency. If the LDO output is used to bias the SiC401A/B, then after switch-over the device is self-powered from the switching regulator with the LDO turned off.

The switch-over starts 32 switching cycles after P<sub>GOOD</sub>

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output goes high. The voltages at the V<sub>DD</sub> and V<sub>OUT</sub> pins are then compared; if the two voltages are within  $\pm$  300 mV of each other, the V<sub>DD</sub> pin connects to the V<sub>OUT</sub> pin using an internal switch, and the LDO is turned off. To avoid unwanted switch-over, the minimum difference between the voltages for V<sub>OUT</sub> and V<sub>DD</sub> should be  $\pm$  500 mV.

It is not recommended to use the switch-over feature for an output voltage less than  $V_{\text{DD}}$  UVLO threshold since the SiC401A/B is not operational below that threshold.

#### Switch-Over MOSFET Parasitic Diodes

The switch-over MOSFET contains parasitic diodes that are inherent to its construction, as shown in Fig. 12. If the voltage at the V<sub>OUT</sub> pin is higher than V<sub>DD</sub>, then the respective diode will turn on and the current will flow through this diode. This has the potential of damaging the device. Therefore, V<sub>OUT</sub> must be less than V<sub>DD</sub> to prevent damaging the device.

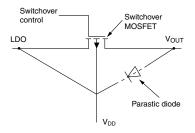


Fig. 12 - Switch-Over MOSFET Parasitic Diodes

#### **Design Procedure**

When designing a switch mode supply the input voltage range, load current, switching frequency, and inductor ripple current must be specified.

The maximum input voltage (V<sub>IN max.</sub>) is the highest specified input voltage. The minimum input voltage (V<sub>IN min.</sub>) is determined by the lowest input voltage after evaluating the voltage drops due to connectors, fuses, switches, and PCB traces.

The following parameters define the design:

- Nominal output voltage (V<sub>OUT</sub>)
- Static or DC output tolerance
- Transient response
- Maximum load current (I<sub>OUT</sub>)

There are two values of load current to evaluate - continuous load current and peak load current. Continuous load current relates to thermal stresses which drive the selection of the inductor and input capacitors. Peak load current determines instantaneous component stresses and filtering requirements such as inductor saturation, output capacitors, and design of the current limit circuit.

The following values are used in this design:

- V<sub>IN</sub> = 12 V ± 10 %
- V<sub>OUT</sub> = 1.5 V ± 4 %
- f<sub>SW</sub> = 300 kHz
- Load = 15 A max.

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#### **Frequency Selection**

Selection of the switching frequency requires making a trade-off between the size and cost of the external filter components (inductor and output capacitor) and the power conversion efficiency.

The desired switching frequency is 300 kHz which results from using component selected for optimum size and cost.

A resistor ( $R_{tON}$ ) is used to program the on-time (indirectly setting the frequency) using the following equation.

$$R_{ton} = \frac{k}{25 \text{ pF x f}_{SW}}$$

To select  $R_{tON},$  use the maximum value for  $V_{IN},$  and for  $t_{ON}$  use the value associated with maximum  $V_{IN}.$ 

$$t_{ON} = \frac{V_{OUT}}{V_{INmax.} x f_{SW}}$$

Substituting for  $R_{tON}$  results in the following solution.

 $R_{tON} = 133.3 \text{ k}\Omega$ , use  $R_{tON} = 130 \text{ k}\Omega$ .

#### Inductor Selection

In order to determine the inductance, the ripple current must first be defined. Low inductor values result in smaller size but create higher ripple current which can reduce efficiency. Higher inductor values will reduce the ripple current/voltage and for a given DC resistance are more efficient. However, larger inductance translates directly into larger packages and higher cost. Cost, size, output ripple, and efficiency are all used in the selection process.

The ripple current will also set the boundary for  $P_{Save}$  operation. The switching will typically enter  $P_{Save}$  mode when the load current decreases to 1/2 of the ripple current. For example, if ripple current is 4 A then  $P_{Save}$  operation will typically start for loads less than 2 A. If ripple current is set at 40 % of maximum load current, then  $P_{Save}$  will start for loads less than 20 % of maximum current.

The inductor value is typically selected to provide a ripple current that is between 25 % to 50 % of the maximum load current. This provides an optimal trade-off between cost, efficiency, and transient performance.

During the on-time, voltage across the inductor is (V\_{IN} - V\_{OUT}). The equation for determining inductance is shown next.

$$L = \frac{(V_{IN} - V_{OUT}) \times t_{ON}}{I_{RIPPLE}}$$

#### Example

In this example, the inductor ripple current is set equal to 30 % of the maximum load current. Thus ripple current will be 30 % x 15 A or 4.5 A. To find the minimum inductance needed, use the  $V_{\rm IN}$  and  $t_{\rm ON}$  values that correspond to  $V_{\rm INmax}.$ 

$$L = \frac{(13.2 - 1.5) \text{ x } 379 \text{ ns}}{4.5 \text{ A}} = 0.99 \text{ } \mu\text{H}$$

A slightly larger value of 1  $\mu H$  is selected. This will decrease the maximum  $I_{\text{RIPPLE}}$  to 4.43 A.

Note that the inductor must be rated for the maximum DC load current plus 1/2 of the ripple current.

The ripple current under minimum  $V_{\text{IN}}$  conditions is also checked using the following equations.

$$t_{ON\_VINmin.} = \frac{25 \text{ pF x R}_{tON x V_{OUT}}}{V_{INmin.}} = 451 \text{ ns}$$

$$I_{RIPPLE} = \frac{(V_{IN} - V_{OUT}) \times t_{ON}}{L}$$

$$I_{RIPPLE\_VINmin.} = \frac{(10.8 - 1.5) \times 451 \text{ ns}}{1 \text{ uH}} = 4.19 \text{ A}$$

#### **Capacitor Selection**

The output capacitors are chosen based upon required ESR and capacitance. The maximum ESR requirement is controlled by the output ripple requirement and the DC tolerance. The output voltage has a DC value that is equal to the valley of the output ripple plus 1/2 of the peak-to-peak ripple.

A change in the output ripple voltage will lead to a change in DC voltage at the output.

The design goal for output voltage ripple is 3 % of 1.5 V or 45 mV. The maximum ESR value allowed is shown by the following equations.

$$\text{ESR}_{\text{max.}} = \frac{\text{V}_{\text{RIPPLE}}}{\text{I}_{\text{RIPPLEmax.}}} = \frac{45 \text{ mV}}{4.43 \text{ A}}$$
$$\text{ESR}_{\text{max}} = 10.2 \text{ mO}$$

The output capacitance is usually chosen to meet transient requirements. A worst-case load release, from maximum load to no load at the exact moment when inductor current is at the peak, determines the required capacitance. If the load release is instantaneous (load changes from maximum to zero in < 1  $\mu$ s), the output capacitor must absorb all the inductor's stored energy. This will cause a peak voltage on the capacitor according to the following equation.

$$C_{OUT\_min.} = \frac{L (I_{OUT} + \frac{1}{2} \times I_{RIPPLEmax.})^2}{(V_{PEAK})^2 - (V_{OUT})^2}$$

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Assuming a peak voltage VPEAK of 1.65 V (150 mV rise upon load release), and a 15 A load release, the required capacitance is shown by the next equation.

$$C_{OUT\_min.} = \frac{1 \ \mu H \ (10 + \frac{1}{2} \times 4.43)^2}{(1.65)^2 - (1.5)^2}$$
  
$$C_{OUT\_min.} = 316 \ \mu F$$

During the load release time, the voltage cross the inductor is approximately - V<sub>OUT</sub>. This causes a down-slope or falling di/dt in the inductor. If the load dl/dt is not much faster than the dl/dt of the inductor, then the inductor current will tend to track the falling load current. This will reduce the excess inductive energy that must be absorbed by the output capacitor; therefore a smaller capacitance can be used.

The following can be used to calculate the needed capacitance for a given  $dI_{I,OAD}/dt$ .

Peak inductor current is shown by the next equation.

 $I_{LPK} = I_{max.} + 1/2 \times I_{RIPPLE max.}$ 

I<sub>LPK</sub> = 10 + 1/2 x 4.43 = 12.215 A

Rate of change of load current =  $\frac{dI_{LOAD}}{dt}$ 

I<sub>max.</sub> = maximum load release = 15 A

$$C_{OUT} = I_{LPK} x \frac{L x \frac{I_{LPK}}{V_{OUT}} - \frac{I_{max.}}{dI_{LOAD}} x dt}{2 (V_{PK} - V_{OUT})}$$

Example

$$\frac{dI_{LOAD}}{dt} = \frac{2.5 \text{ A}}{1 \text{ }\mu\text{s}}$$

This would cause the output current to move from 15 A to 0 A in 4 µs, giving the minimum output capacitance requirement shown in the following equation.

$$C_{OUT} = 12.215 \text{ x} \frac{1 \ \mu\text{H x} \frac{12.215}{1.5} - \frac{10}{2.5} \text{ x} \ 1 \ \mu\text{s}}{2 \ (1.65 - 1.5)}$$

$$C_{OUT} = 169 \ \mu\text{F}$$

Note that C<sub>OUT</sub> is much smaller in this example, 169 µF compared to 316 µF based on a worst case load release. To meet the two design criteria of minimum 316 µF and maximum 10.2 mW ESR, select one capacitor of 330 µF and 9 mW ESR.

#### **Stability Considerations**

Unstable operation is possible with adaptive on-time controllers, and usually takes the form of double-pulsing or ESR loop instability.

Double-pulsing occurs due to switching noise seen at the FB input or because the FB ripple voltage is too low. This causes the FB comparator to trigger prematurely after the

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250 ns minimum off-time has expired. In extreme cases the noise can cause three or more successive on-times. Double-pulsing will result in higher ripple voltage at the output, but in most applications it will not affect operation. This form of instability can usually be avoided by providing the FB pin with a smooth, clean ripple signal that is at least 10 mV<sub>p-p</sub>, which may dictate the need to increase the ESR of the output capacitors. It is also imperative to provide a proper PCB layout as discussed in the Layout Guidelines section.

Another way to eliminate doubling-pulsing is to add a small (~ 10 pF) capacitor across the upper feedback resistor, as shown in Fig. 13. This capacitor should be left unpopulated until it can be confirmed that double-pulsing exists. Adding the C<sub>TOP</sub> capacitor will couple more ripple into FB to help eliminate the problem. An optional connection on the PCB should be available for this capacitor.

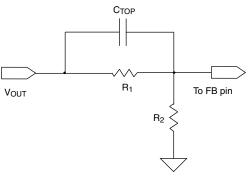


Fig. 13 - Capacitor Coupling to FB Pin

ESR loop instability is caused by insufficient ESR. The details of this stability issue are discussed in the ESR Requirements section. The best method for checking stability is to apply a zero-to-full load transient and observe the output voltage ripple envelope for overshoot and ringing. Ringing for more than one cycle after the initial step is an indication that the ESR should be increased.

#### **ESR Requirements**

A minimum ESR is required for two reasons. One reason is to generate enough output ripple voltage to provide 10 mV<sub>p-p</sub> at the FB pin (after the resistor divider) to avoid double-pulsing.

The second reason is to prevent instability due to insufficient ESR. The on-time control regulates the valley of the output ripple voltage. This ripple voltage is the sum of the two voltages. One is the ripple generated by the ESR, the other is the ripple due to capacitive charging and discharging during the switching cycle. For most applications the minimum ESR ripple voltage is dominated by the output capacitors, typically SP or POSCAP devices. For stability the ESR zero of the output capacitor should be lower than approximately one-third the switching frequency. The formula for minimum ESR is shown by the following

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equation.

$$\text{ESR}_{\text{min.}} = \frac{3}{2 \, x \, \pi \, x \, \text{C}_{\text{OUT}} \, x \, \text{f}_{\text{SW}}}$$

#### Using Ceramic Output Capacitors

When the system is using high ESR value capacitors, the feedback voltage ripple lags the phase node voltage by 90°. Therefore, the converter is easily stabilized. When the system is using ceramic output capacitors, the ESR value is normally too small to meet the above ESR criteria. As a result, the feedback voltage ripple is 180° from the phase node and behaves in an unstable manner. In this application it is necessary to add a small virtual ESR network that is composed of two capacitors and one resistor, as shown in Fig. 14.

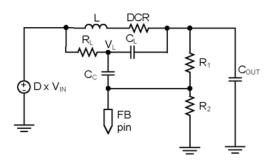


Fig. 14 - Virtual ESR Ramp Current

The ripple voltage at FB is a superposition of two voltage sources: the voltage across  $C_L$  and output ripple voltage. They are defined in the following equations.

$$V_{CL} = \frac{I_L \times DCR (s \times L/DCR + 1)}{S \times R_L \times C_L + 1}$$
$$\Delta V_{OUT} = \frac{\Delta I_L}{8C \times f_{SW}}$$

Fig. 15 shows the magnitude of the ripple contribution due to  $C_L$  at the FB pin.

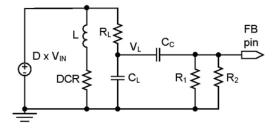


Fig. 15 - FB Voltage by CL Voltage

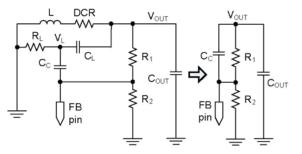
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It is shown by the following equation.

$$\text{/FB}_{\text{CL}} = \text{V}_{\text{CL}} \times \frac{(\text{R}_{1} / / \text{R}_{2}) \times \text{S} \times \text{C}_{\text{C}}}{(\text{R}_{1} / / \text{R}_{2}) \times \text{S} \times \text{C}_{\text{C}} + 1}$$

Fig. 16 shows the magnitude of the ripple contribution due to the output voltage ripple at the FB pin.



**Fig. 16 - FB Voltage by Output Voltage** It is shown by the following equation.

$$VFB\Delta V_{OUT} = \Delta V_{OUT} \times \frac{R_2}{R_1 / \frac{1}{S \times C_C} + R_2}$$

It is recommended that R<sub>2</sub> be set to 1k.

The purpose of this network is to couple the inductor current ripple information into the feedback voltage such that the feedback voltage has 90° phase lag to the switching node similar to the case of using standard high ESR capacitors. This is illustrated in Fig. 17.

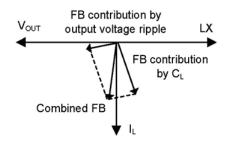


Fig. 17 - FB Voltage in Phasor Diagram

The magnitude of the feedback ripple voltage, which is dominated by the contribution from C<sub>L</sub>, is controlled by the value of R<sub>1</sub>, R<sub>2</sub> and C<sub>C</sub>. If the corner frequency of (R<sub>1</sub>//R<sub>2</sub>) x C<sub>C</sub> is too high, the ripple magnitude at the FB pin will be smaller, which can lead to double-pulsing. Conversely, if the corner frequency of (R<sub>1</sub>//R<sub>2</sub>) x C<sub>C</sub> is too low, the ripple magnitude at FB pin will be higher. Since the SiC401A/B regulates to the valley of the ripple voltage at the FB pin, a high ripple magnitude is undesirable as it significantly impacts the output voltage regulation. As a result, it is desirable to select a corner frequency for (R<sub>1</sub>//R<sub>2</sub>) x C<sub>C</sub> to achieve enough, but not excessive, ripple magnitude and phase margin. The component values for R<sub>1</sub>, R<sub>2</sub>, and C<sub>C</sub> should be calculated using the following procedure.

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Select  $C_L$  (typical 10 nF) and  $R_L$  to match with L and DCR time constant using the following equation.

$$R_{L} = \frac{L}{DCR \times C_{L}}$$

Select C<sub>C</sub> by using the following equation.

$$C_{C} \approx \frac{1}{R_{1} / / R_{2}} \times \frac{3}{2 x \pi x f_{SW}}$$

The resistor values ( $R_1$  and  $R_2$ ) in the voltage divider circuit set the V<sub>OUT</sub> for the switcher. The typical value for C<sub>C</sub> is from 10 pF to 1 nF.

#### **Dropout Performance**

The output voltage adjustment range for continuous conduction operation is limited by the fixed 250 ns (typical) minimum off-time of the one-shot. When working with low input voltages, the duty-factor limit must be calculated using worst-case values for on and off times.

The duty-factor limitation is shown by the next equation.

$$DUTY = \frac{t_{ON(min.)}}{t_{ON(min.)} \times t_{OFF(max.)}}$$

The inductor resistance and MOSFET on-state voltage drops must be included when performing worst-case dropout duty-factor calculations.

#### System DC Accuracy (VOUT Controller)

Three factors affect  $V_{OUT}$  accuracy: the trip point of the FB error comparator, the ripple voltage variation with line and load, and the external resistor tolerance. The error comparator offset is trimmed so that under static conditions it trips when the feedback pin is 600 mV, 1 %.

The on-time pulse from the SiC401A/B in the design example is calculated to give a pseudo-fixed frequency of 300 kHz. Some frequency variation with line and load is expected. This variation changes the output ripple voltage. Because adaptive on-time converters regulate to the valley of the output ripple, ½ of the output ripple appears as a DC regulation error. For example, if the output ripple is 50 mV with V<sub>IN</sub> = 6 V, then the measured DC output will be 25 mV above the comparator trip point.

If the ripple increases to 80 mV with  $V_{IN} = 17$  V, then the measured DC output will be 40 mV above the comparator trip. The best way to minimize this effect is to minimize the output ripple.

The use of 1 % feedback resistors may result in up to 1 % error. If tighter DC accuracy is required, 0.1 % resistors should be used.

The output inductor value may change with current. This will change the output ripple and therefore will have a minor effect on the DC output voltage. The output ESR also affects the output ripple and thus has a minor effect on the DC output voltage.

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The switching frequency varies with load current as a result of the power losses in the MOSFETs and DCR of the inductor. For a conventional PWM constant-frequency converter, as load increases the duty cycle also increases slightly to compensate for IR and switching losses in the MOSFETs and inductor. An adaptive on-time converter must also compensate for the same losses by increasing the effective duty cycle (more time is spent drawing energy from  $V_{\rm IN}$  as losses increase). The on-time is essentially constant for a given  $V_{\rm OUT}/V_{\rm IN}$  combination, to offset the losses the off-time will tend to reduce slightly as load increases. The net effect is that switching frequency increases slightly with increasing load.

#### **HIGH OUTPUT VOLTAGE OPERATION**

F

For the SiC40X family the recommended maximum output voltage of no more than 75 % of  $V_{\text{IN}}.$ 

For applications where an output voltage greater than 5 V is required a resistive network should be used to step down the output voltage in order to provide the  $V_{OUT}$  PIN with 4.5 V.

$$R_1 = \frac{R_2 (V_{OUT} - V_{OUT\_PIN})}{V_{OUT\_PIN}}$$

For example, if an output voltage of V<sub>OUT</sub> = 8.5 V is required, setting R<sub>2</sub> = 10 k $\Omega$  and V<sub>OUT\_PIN</sub> = 4.5 V results in R<sub>1</sub> = 8870  $\Omega$ . The switching frequency will also need recalculating using a V<sub>OUT\_PIN</sub> magnitude of 4.5 V.

$$f_{sw} = \frac{V_{OUT\_PIN}}{t_{ON} \times V_{IN}}$$

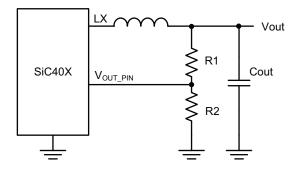


Fig. 18 - Resistor Divider Network allows 4.5 V at the  $V_{\text{OUT}}$  Pin

Switching Frequency Variation

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### LAYOUT CONSIDERATIONS

The SiC40x family of footprint compatible 15 A, 10 A, and 6 A products offers the designer a scalable buck regulator solution. If the below layout recommendations are followed, the same layout can be used to cover a wide range of output currents and voltages without any changes to the board design and only minor changes to the component values in the schematic.

The reference design has a majority of the components placed on the top layer. This allows for easy assembly and straightforward layout.

Fig. 19 outlines the pointers for the layout considerations and the explanations follow.

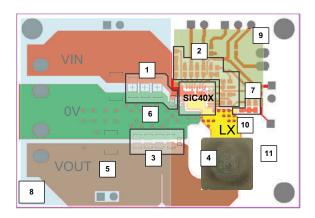


Fig. 19 - Reference Design Pointers

- 1. Place input ceramic capacitors close to the voltage input pins with a small 10 nF/100 nF placed as close as the design rules will allow. This will help reduce the size of the input high frequency current loop and consequently reduce the high frequency ripple noise seen at the input and the LX node.
- 2. Place the setup and control passive devices logically around the IC with the intention of placing a quiet ground plane beneath them on a secondary layer.

- 3. It is advisable to use ceramic capacitors at the output to reduce impedance. Place these as close to the IC  $P_{GND}$  and output voltage node as design will allow. Place a small 10 nF/100 nF ceramic capacitor closest to the IC and inductor loop.
- 4. The loop between LX,  $V_{OUT}$  and the IC GND should be as compact as possible. This will lower series resistance and also make the current loop smaller enabling the high frequency response of the output capacitors to take effect.
- 5. The output impedance should be small when high current is required; use high current traces, multiple layers can be used with many vias.
- 6. Use many vias when multiple layers are involved. This will have the effect of lowering the resistance between layers and reducing the via inductance of the PCB nets.
- 7. If a voltage injection network is needed then place it near to the inductor LX node.
- P<sub>GND</sub> can be used on internal layers if the resistance of the PCB is to be small; this will also help remove heat. Use extra vias if needed but be mindful to allow a path between the vias.
- 9. A quiet plane should be employed for the  $A_{GND}$ , this is placed under the small signal passives. This can be placed on multiple layers if needed for heat removal. This should be connected to the  $P_{GND}$  plane near to the input GND at one connection only of at least 1 mm width.
- 10. The LX copper can also be used on multiple layers, use a number of vias.
- 11. The copper area beneath the inductor has been removed (on all layers) in this design to reduce the inductive coupling that occurs between the inductor and the GND trace. No other voltage planes should be placed under this area.



### PCB LAYOUT

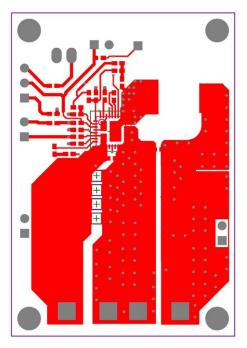


Fig. 20 - Top Layer

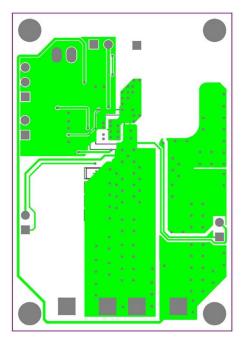


Fig. 21 - Inner Layer 1

## SiC401A, SiC401BCD

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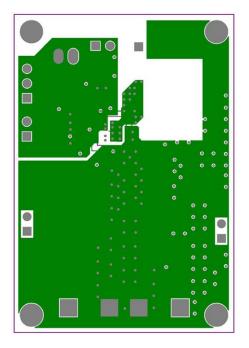


Fig. 22 - Inner Layer 2

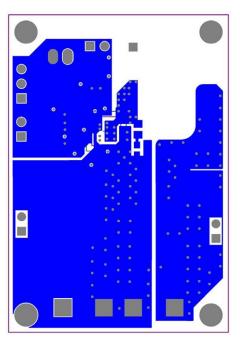
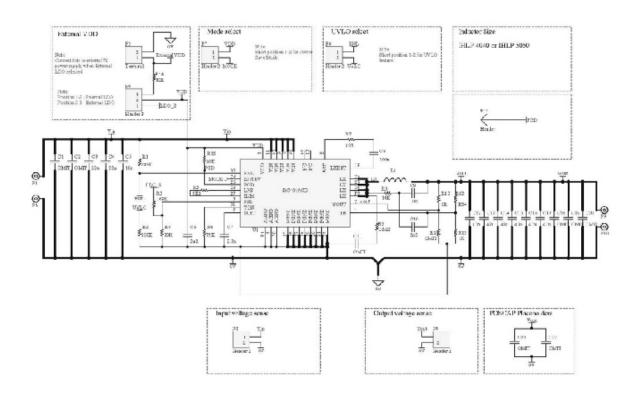


Fig. 23 - Bottom Layer



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### SCHEMATIC



#### Note

• If OUT voltage setting  $\geq$  5 V<sub>DC</sub>, please change R10 and R11 value based on "High Output Voltage Operation" formula calculation



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<b>HTEOTYREFERENCEPORT</b> PORT <b>VALUEVOLTAGEPART NUMBERMANUFACTURER</b> 12Cf.(2)12060mit35VC3216X5R1V220M160ACTDK22CG.3, C4120622 µF35VC3216X5R1V226M160ACTDK33CS, CS, C12040210 nF50VGRM15SR71H03KA8BMurata41CG.2CG.210 NC040225M8PACTUKemeta52CT, C1004022.2 µF10 NC040225M8PACTUKemeta61CG.2CG.2S0 NGRM15SR71H03KA8BWurata75C13,C14,C15,C16,C1120 N47 µF10 VGRM31CR1A476M151Murata83C18,C19,C20733Omit10 VGRM31CR1A476M151Murata92C21,C22734Omit10 VGRM31CR1A476ME151Murata93C13,C14,C15,C16,C1736Omit10 VGRM31CR1A476ME151Murata104P1,P3,P9,P10BananakaC1SGRM31CR1A476ME151Murata111P2,P4,P5,P78Header21<SSSS1212,P4,P59,P18Bananaka1IRCW040210KFKEDSS1314NL1HEADS1CSSS1412,P44,P59,P18Murata1SSSS1512,P44,P59,P18Murata	BILL	OF N	IATERIALS (V <sub>IN</sub> = 12	V, V <sub>OUT</sub> = 1	.5 V, F <sub>sw</sub> =	500 kHz)		
2         2         C3, C4         1206         22 μF         35 V         C3216X5R1V226M160AC         TDK           3         3         C5, C9, C12         0402         10 nF         50 V         GRM155R71H103KA88D         Murata           4         1         C6         0402         2.2 μF         10 V         C0402C225M8PACTU         Kemet           5         2         C7, C10         0402         2.2 μF         50 V         GRM155R71H222KA01D         Murata           6         1         C8         0402         100 nF         35 V         GGA2B3X7R1V104K050BB         Vishay           7         5         C13, C14, C15, C16, C17         1206         47 μF         10 V         GRM31CR61A476ME15L         Murata           8         3         C18, C19, C20         1206         Omit         10 V         GRM31CR61A476ME15L         Murata           9         2         C21, C22         7343         Omit         -         575-4K-ND         Keystone           11         5         P2, P4, P5, P7, P8         Header-2         -         -         826926-2         AMP (TE)           12         1         P6         Header-3         -         HTSW-103-08-T-S <td< th=""><th>ITEM</th><th>QTY</th><th>REFERENCE</th><th></th><th>VALUE</th><th>VOLTAGE</th><th>PART NUMBER</th><th>MANUFACTURER</th></td<>	ITEM	QTY	REFERENCE		VALUE	VOLTAGE	PART NUMBER	MANUFACTURER
3         3         C5, C9, C12         0402         10 nF         50 V         GRM155R71H103KA88D         Murata           4         1         C6         0402         2.2 µF         10 V         C0402C225M8PACTU         Kernet           5         2         C7, C10         0402         2.2 µF         50 V         GRM155R71H22KA01D         Murata           6         1         C8         0402         100 nF         35 V         CGA2B3X7R1V104K050BB         Vishay           7         5         C13, C14, C15, C16, C17         1206         47 µF         10 V         GRM31CR61A476ME15L         Murata           8         3         C18, C19, C20         1206         Omit         10 V         GRM31CR61A476ME15L         Murata           9         2         C21, C22         7343         Omit         -         575-4K-ND         Keystone           11         5         P2, P4, P5, P7, P8         Header-2         -         -         HTSW-103-08-T-S         Samtec           12         1         P6         Header-2         -         -         HTSW-103-08-T-S         Samtec           13         1         L1         IHLP5050         1 µH         -         IHTSW-103-08-	1	2	C1, C2	1206	Omit	35 V	C3216X5R1V226M160AC	TDK
4         1         C6         0402         2.2 µF         10 V         C0402C225M8PACTU         Kemet           5         2         C7, C10         0402         2.2 nF         50 V         GRM155R71H222KA01D         Murata           6         1         C8         0402         100 nF         35 V         CGA2B3X7R1V104K050BB         Vishay           7         5         C13, C14, C15, C16, C17         1206         47 µF         10 V         GRM31CR61A476ME15L         Murata           8         3         C18, C19, C20         1206         Omit         10 V         GRM31CR61A476ME15L         Murata           9         2         C21, C22         7343         Omit         -         -         -         -           10         4         P1, P3, P9, P10         Banana Jack         -         -         -         826926-2         AMP (TE)           12         1         P6         Header-3         -         -         HTSW-103-08-T-S         Samtec           13         1         L1         IHLP5050         1 µH         -         IHLP5050FDER1R0         Vishay           15         1         R1         0402         249K         -         CRCW040210	2	2	C3, C4	1206	22 µF	35 V	C3216X5R1V226M160AC	TDK
5         2         C7, C10         0402         2.2 nF         50 V         GRM155R71H222KA01D         Murata           6         1         C8         0402         100 nF         35 V         CGA2B3X7R1V104K050BB         Vishay           7         5         C13, C14, C15, C16, C17         1206         47 μF         10 V         GRM31CR61A476ME15L         Murata           8         3         C18, C19, C20         1206         Omit         10 V         GRM31CR61A476ME15L         Murata           9         2         C21, C22         7343         Omit         -         -         -         -           10         4         P1, P3, P9, P10         Banan Jack         -         -         826926-2         AMP (TE)           12         1         P6         Header-2         -         -         HTSW-103-08-TS         Samtec           13         1         L1         IHLP5050         1 μH         -         IHLP5050FDER1R0         Vishay           15         1         R1         0402         249K         -         CRCW0402249KFKED         Vishay           16         1         R3         0402         106K         -         CRCW0402100KFKED <td< td=""><td>3</td><td>3</td><td>C5, C9, C12</td><td>0402</td><td>10 nF</td><td>50 V</td><td>GRM155R71H103KA88D</td><td>Murata</td></td<>	3	3	C5, C9, C12	0402	10 nF	50 V	GRM155R71H103KA88D	Murata
6         1         C3         0402         100 nF         35 V         CGA2B3X7R1V104K050BB         Vishay           7         5         C13, C14, C15, C16, C17         1206         47 µF         10 V         GRM31CR61A476ME15L         Murata           8         3         C18, C19, C20         1206         Omit         10 V         GRM31CR61A476ME15L         Murata           9         2         C21, C22         7343         Omit         -         -         -         -           10         4         P1, P3, P9, P10         Banana Jack         -         -         575-4K-ND         Keystone           11         5         P2, P4, P5, P7, P8         Header-2         -         -         826926-2         AMP (TE)           12         1         P6         Header-3         -         -         HTSW-103-08-T-S         Samtec           13         1         L1         IHLP5050         1 µH         -         IHLP5050FDER1R0         Vishay           14         1         R1         0402         249K         -         CRCW0402100KFKED         Vishay           15         1         R1         R2         0402         100K         -         CRCW0402100	4	1	C6	0402	2.2 µF	10 V	C0402C225M8PACTU	Kemet
7         5         C13, C14, C15, C16, C17         1206         47 μF         10 V         GRM31CR61A476ME15L         Murata           8         3         C18, C19, C20         1206         Omit         10 V         GRM31CR61A476ME15L         Murata           9         2         C21, C22         7343         Omit         -         -         -           10         4         P1, P3, P9, P10         Banana Jack         -         -         826926-2         AMP (TE)           11         5         P2, P4, P5, P7, P8         Header-3         -         -         HTSW-103-08-T-S         Samtec           13         1         L1         IHLP5050         1 μH         -         IHLP5050FDER1R0         Vishay           14         1         R1         0402         249K         -         CRCW0402200KFKED         Vishay           15         1         R2         0402         100K         -         CRCW0402100KFKED         Vishay           16         1         R3         0402         169K         -         CRCW0402109KFKED         Vishay           17         1         R4         0402         30K         -         CRCW0402169KFKED         Vishay <td>5</td> <td>2</td> <td>C7, C10</td> <td>0402</td> <td>2.2 nF</td> <td>50 V</td> <td>GRM155R71H222KA01D</td> <td>Murata</td>	5	2	C7, C10	0402	2.2 nF	50 V	GRM155R71H222KA01D	Murata
8         3         C18, C19, C20         1206         Omit         10 V         GRM31CR61A476ME15L         Murata           9         2         C21, C22         7343         Omit         -         -         -           10         4         P1, P3, P9, P10         Banan Jack         -         -         575-4K-ND         Keystone           11         5         P2, P4, P5, P7, P8         Header-2         -         -         826926-2         AMP (TE)           12         1         P6         Header-3         -         -         HTSW-103-08-T-S         Samtec           13         1         L1         IHLP5050         1 µH         -         IHLP5050FDER1R0         Vishay           14         1         R1         0402         249K         -         CRCW040219KFKED         Vishay           15         1         R2         0402         100K         -         CRCW040210KFKED         Vishay           16         1         R3         0402         30K         -         CRCW040210KFKED         Vishay           17         1         R4         0402         30K         -         CRCW040210KFKED         Vishay           18	6	1	C8	0402	100 nF	35 V	CGA2B3X7R1V104K050BB	Vishay
9         2         C21, C22         7343         Omit         -         -         -           10         4         P1, P3, P9, P10         Banana Jack         -         -         575-4K-ND         Keystone           11         5         P2, P4, P5, P7, P8         Header-2         -         -         826926-2         AMP (TE)           12         1         P6         Header-3         -         -         HTSW-103-08-T-S         Samtec           13         1         L1         IHLP5050         1 μH         -         HTSW-103-08-T-S         Samtec           13         1         L1         IHLP5050         1 μH         -         HTSW-103-08-T-S         Samtec           13         1         L1         IHLP5050         1 μH         -         Keystone         Vishay           14         1         R1         0402         249K         -         CRCW0402100KFKED         Vishay           15         1         R2         0402         100K         -         CRCW0402100KFKED         Vishay           16         1         R3         0402         5K11         -         CRCW04025K1FKED         Vishay           18         1 </td <td>7</td> <td>5</td> <td>C13, C14, C15, C16, C17</td> <td>1206</td> <td>47 µF</td> <td>10 V</td> <td>GRM31CR61A476ME15L</td> <td>Murata</td>	7	5	C13, C14, C15, C16, C17	1206	47 µF	10 V	GRM31CR61A476ME15L	Murata
10         4         P1, P3, P9, P10         Banana Jack         -         .         575-4K-ND         Keystone           11         5         P2, P4, P5, P7, P8         Header-2         -         -         826926-2         AMP (TE)           12         1         P6         Header-3         -         -         HTSW-103-08-T-S         Samtec           13         1         L1         IHLP5050         1 μH         -         IHLP5050FDER1R0         Vishay           14         1         R1         0402         249K         -         CRCW0402249KFKED         Vishay           15         1         R2         0402         100K         -         CRCW0402100KFKED         Vishay           16         1         R3         0402         169K         -         CRCW040230K0FKED         Vishay           17         1         R4         0402         30K         -         CRCW040230K0FKED         Vishay           18         1         R5         0402         5K11         -         CRCW04025K11FKED         Vishay           20         1         R7         0402         10R         -         CRCW040210R0FKEA         Vishay           21	8	3	C18, C19, C20	1206	Omit	10 V	GRM31CR61A476ME15L	Murata
11         5         P2, P4, P5, P7, P8         Header-2         -         -         826926-2         AMP (TE)           12         1         P6         Header-3         -         -         HTSW-103-08-T-S         Samtec           13         1         L1         IHLP5050         1 µH         -         IHLP5050FDER1R0         Vishay           14         1         R1         0402         249K         -         CRCW0402249KFKED         Vishay           15         1         R2         0402         100K         -         CRCW040210KFKED         Vishay           16         1         R3         0402         169K         -         CRCW0402108FKED         Vishay           17         1         R4         0402         30K         -         CRCW040230K0FKED         Vishay           18         1         R5         0402         5K11         -         CRCW040276K8FKED         Vishay           19         1         R6         0402         76K8         -         CRCW040210R0FKEA         Vishay           20         1         R7         0402         10R         -         CRCW040210K0FKED         Vishay           21         1 </td <td>9</td> <td>2</td> <td>C21, C22</td> <td>7343</td> <td>Omit</td> <td>-</td> <td>-</td> <td>-</td>	9	2	C21, C22	7343	Omit	-	-	-
12         1         P6         Header-3         -         -         HTSW-103-08-T-S         Samtec           13         1         L1         IHLP5050         1 µH         -         IHLP5050FDER1R0         Vishay           14         1         R1         0402         249K         -         CRCW0402249KFKED         Vishay           15         1         R2         0402         100K         -         CRCW0402100KFKED         Vishay           16         1         R3         0402         169K         -         CRCW0402100KFKED         Vishay           17         1         R4         0402         30K         -         CRCW040230K0FKED         Vishay           18         1         R5         0402         5K11         -         CRCW040276K8FKED         Vishay           19         1         R6         0402         76K8         -         CRCW040210R0FKEA         Vishay           20         1         R7         0402         10R         -         CRCW040210R0FKEA         Vishay           21         1         R8         0402         10K         -         CRCW040210K0FKED         Vishay           22         1	10	4	P1, P3, P9, P10	Banana Jack	-	-	575-4K-ND	Keystone
13         1         L1         IHLP5050         1 μH         -         IHLP5050FDER1R0         Vishay           14         1         R1         0402         249K         -         CRCW0402249KFKED         Vishay           15         1         R2         0402         100K         -         CRCW0402100KFKED         Vishay           16         1         R3         0402         169K         -         CRCW0402169KFKED         Vishay           17         1         R4         0402         30K         -         CRCW040230K0FKED         Vishay           18         1         R5         0402         5K11         -         CRCW04025K11FKED         Vishay           19         1         R6         0402         76K8         -         CRCW040210R0FKEA         Vishay           20         1         R7         0402         10R         -         CRCW040210R0FKEA         Vishay           21         1         R8         0402         10K         -         CRCW040210R0FKED         Vishay           22         1         R9         0805         Omit         -         Vishay           23         1         R10         0402 </td <td>11</td> <td>5</td> <td>P2, P4, P5, P7, P8</td> <td>Header-2</td> <td>-</td> <td>-</td> <td>826926-2</td> <td>AMP (TE)</td>	11	5	P2, P4, P5, P7, P8	Header-2	-	-	826926-2	AMP (TE)
14         1         R1         0402         249K         -         CRCW0402249KFKED         Vishay           15         1         R2         0402         100K         -         CRCW0402100KFKED         Vishay           16         1         R3         0402         169K         -         CRCW0402169KFKED         Vishay           17         1         R4         0402         30K         -         CRCW040230K0FKED         Vishay           18         1         R5         0402         5K11         -         CRCW04025K11FKED         Vishay           19         1         R6         0402         76K8         -         CRCW040210R0FKEA         Vishay           20         1         R7         0402         10R         -         CRCW040210R0FKED         Vishay           21         1         R8         0402         10K         -         CRCW040210R0FKED         Vishay           22         1         R9         0805         Omit         -         Vishay           23         1         R10         0402         0R         -         CRCW04020000Z0ED         Vishay           25         1         R112         0402	12	1	P6	Header-3	-	-	HTSW-103-08-T-S	Samtec
15         1         R2         0402         100K         -         CRCW0402100KFKED         Vishay           16         1         R3         0402         169K         -         CRCW0402100KFKED         Vishay           17         1         R4         0402         30K         -         CRCW0402109KFKED         Vishay           18         1         R4         0402         30K         -         CRCW04025K11FKED         Vishay           19         1         R6         0402         76K8         -         CRCW040210R0FKEA         Vishay           20         1         R7         0402         10R         -         CRCW040210R0FKEA         Vishay           21         1         R8         0402         10R         -         CRCW040210R0FKEA         Vishay           22         1         R9         0805         Omit         -         Vishay           23         1         R10         0402         0R         -         CRCW040210K0FKED         Vishay           24         1         R11         0402         Omit         -         Vishay           25         1         R12         0402         1K54         C	13	1	L1	IHLP5050	1 µH	-	IHLP5050FDER1R0	Vishay
16         1         R3         0402         169K         -         CRCW0402169KFKED         Vishay           17         1         R4         0402         30K         -         CRCW040230K0FKED         Vishay           18         1         R5         0402         5K11         -         CRCW04025K11FKED         Vishay           19         1         R6         0402         76K8         -         CRCW040210R0FKEA         Vishay           20         1         R7         0402         10R         -         CRCW040210R0FKEA         Vishay           21         1         R8         0402         10K         -         CRCW040210R0FKEA         Vishay           22         1         R8         0402         10K         -         CRCW040210R0FKED         Vishay           23         1         R10         0402         0R         -         Vishay           24         1         R11         0402         0Rit         -         Vishay           25         1         R12         0402         1K54         -         CRCW04021K54FKED         Vishay           26         1         R13         0402         1K         -<	14	1	R1	0402	249K	-	CRCW0402249KFKED	Vishay
17         1         R4         0402         30K         -         CRCW040230K0FKED         Vishay           18         1         R5         0402         5K11         -         CRCW040230K0FKED         Vishay           19         1         R6         0402         76K8         -         CRCW040276K8FKED         Vishay           20         1         R7         0402         10R         -         CRCW040210R0FKEA         Vishay           21         1         R8         0402         10K         -         CRCW040210R0FKEA         Vishay           22         1         R8         0402         10K         -         CRCW040210R0FKED         Vishay           23         1         R10         0402         0R         -         Vishay           24         1         R11         0402         0R         -         CRCW040210K0FKED         Vishay           25         1         R11         0402         0mit         -         -         Vishay           26         1         R13         0402         1K         -         CRCW040210R0FKED         Vishay           27         1         R14         0402         10R <td>15</td> <td>1</td> <td>R2</td> <td>0402</td> <td>100K</td> <td>-</td> <td>CRCW0402100KFKED</td> <td>Vishay</td>	15	1	R2	0402	100K	-	CRCW0402100KFKED	Vishay
18         1         R5         0402         5K11         -         CRCW04025K11FKED         Vishay           19         1         R6         0402         76K8         -         CRCW040276K8FKED         Vishay           20         1         R7         0402         10R         -         CRCW040210R0FKEA         Vishay           21         1         R8         0402         10K         -         CRCW040210K0FKED         Vishay           22         1         R8         0402         10K         -         CRCW040210K0FKED         Vishay           22         1         R9         0805         Omit         -         Vishay           23         1         R10         0402         0R         -         CRCW0402000Z0ED         Vishay           24         1         R11         0402         Omit         -         Vishay           25         1         R12         0402         1K54         -         CRCW04021K54FKED         Vishay           26         1         R13         0402         1K         -         CRCW040210R0FKEA         Vishay           27         1         R14         0402         10R         -<	16	1	R3	0402	169K	-	CRCW0402169KFKED	Vishay
19         1         R6         0402         76K8         -         CRCW040276K8FKED         Vishay           20         1         R7         0402         10R         -         CRCW040210R0FKEA         Vishay           21         1         R8         0402         10K         -         CRCW040210R0FKEA         Vishay           22         1         R8         0402         10K         -         CRCW040210K0FKED         Vishay           22         1         R9         0805         Omit         -         Vishay           23         1         R10         0402         0R         -         CRCW0402000Z0ED         Vishay           24         1         R11         0402         Omit         -         -         Vishay           25         1         R12         0402         1K54         -         CRCW04021K54FKED         Vishay           26         1         R13         0402         1K         -         CRCW040210R0FKEA         Vishay           27         1         R14         0402         10R         -         CRCW040210R0FKEA         Vishay           28         1         R15         0402         10K<	17	1	R4	0402	30K	-	CRCW040230K0FKED	Vishay
20         1         R7         0402         10R         -         CRCW040210R0FKEA         Vishay           21         1         R8         0402         10K         -         CRCW040210K0FKED         Vishay           22         1         R9         0805         Omit         -         -         Vishay           23         1         R10         0402         0R         -         CRCW0402000Z0ED         Vishay           24         1         R11         0402         OR         -         Vishay           25         1         R12         0402         1K54         -         CRCW040210K0FKED         Vishay           26         1         R13         0402         1K         -         Vishay           26         1         R13         0402         1K         -         CRCW04021K54FKED         Vishay           26         1         R13         0402         10R         -         CRCW040210R0FKEA         Vishay           27         1         R14         0402         10R         -         CRCW040210K0FKED         Vishay           28         1         R15         0402         10K         -	18	1	R5	0402	5K11	-	CRCW04025K11FKED	Vishay
21         1         R8         0402         10K         -         CRCW040210K0FKED         Vishay           22         1         R9         0805         Omit         -         -         Vishay           23         1         R10         0402         0R         -         CRCW04020000Z0ED         Vishay           24         1         R11         0402         ORit         -         -         Vishay           25         1         R12         0402         1K54         -         CRCW04021K54FKED         Vishay           26         1         R13         0402         1K         -         CRCW0402249KFKED         Vishay           27         1         R14         0402         10R         -         CRCW040210K0FKEA         Vishay           28         1         R15         0402         10K         -         CRCW040210K0FKED         Vishay	19	1	R6	0402	76K8	-	CRCW040276K8FKED	Vishay
22         1         R9         0805         Omit         -         Vishay           23         1         R10         0402         0R         -         CRCW04020000Z0ED         Vishay           24         1         R11         0402         Omit         -         Vishay           25         1         R12         0402         1K54         -         CRCW04021K54FKED         Vishay           26         1         R13         0402         1K         -         CRCW0402249KFKED         Vishay           27         1         R14         0402         10R         -         CRCW040210R0FKEA         Vishay           28         1         R15         0402         10K         -         CRCW040210K0FKED         Vishay	20	1	R7	0402	10R	-	CRCW040210R0FKEA	Vishay
23         1         R10         0402         0R         -         CRCW04020000Z0ED         Vishay           24         1         R11         0402         Omit         -         -         Vishay           25         1         R12         0402         1K54         -         CRCW04021K54FKED         Vishay           26         1         R13         0402         1K         -         CRCW0402249KFKED         Vishay           27         1         R14         0402         10R         -         CRCW040210R0FKEA         Vishay           28         1         R15         0402         10K         -         CRCW040210K0FKED         Vishay	21	1	R8	0402	10K	-	CRCW040210K0FKED	Vishay
24         1         R11         0402         Omit         -         Vishay           25         1         R12         0402         1K54         -         CRCW04021K54FKED         Vishay           26         1         R13         0402         1K         -         CRCW0402249KFKED         Vishay           27         1         R14         0402         10R         -         CRCW040210R0FKEA         Vishay           28         1         R15         0402         10K         -         CRCW040210K0FKED         Vishay	22	1	R9	0805	Omit	-	-	Vishay
25         1         R12         0402         1K54         -         CRCW04021K54FKED         Vishay           26         1         R13         0402         1K         -         CRCW0402249KFKED         Vishay           27         1         R14         0402         10R         -         CRCW040210R0FKEA         Vishay           28         1         R15         0402         10K         -         CRCW040210K0FKED         Vishay	23	1	R10	0402	0R	-	CRCW04020000Z0ED	Vishay
26         1         R13         0402         1K         -         CRCW0402249KFKED         Vishay           27         1         R14         0402         10R         -         CRCW040210R0FKEA         Vishay           28         1         R15         0402         10K         -         CRCW040210K0FKED         Vishay	24	1	R11	0402	Omit	-	-	Vishay
27         1         R14         0402         10R         -         CRCW040210R0FKEA         Vishay           28         1         R15         0402         10K         -         CRCW040210K0FKED         Vishay	25	1	R12	0402	1K54	-	CRCW04021K54FKED	Vishay
28         1         R15         0402         10K         -         CRCW040210K0FKED         Vishay	26	1	R13	0402	1K	-	CRCW0402249KFKED	Vishay
	27	1	R14	0402	10R	-	CRCW040210R0FKEA	Vishay
29 1 U1 MLP55-33 SIC401	28	1	R15	0402	10K	-	CRCW040210K0FKED	Vishay
	29	1	U1	MLP55-33	SIC401	-	-	-



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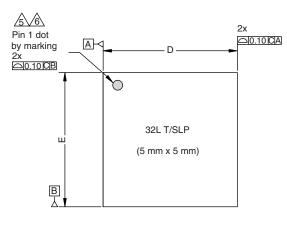
Document Number: 63835

PRODUCT SUMMARY		
Part number	SiC401A	SiC401B
Description	15 A, 3 V to 17 V input, scalable synchronous buck regulator, ultrasonic mode	15 A, 3 V to 17 V input, scalable synchronous buck regulator, powersave mode
Input voltage min. (V)	3	3
Input voltage max. (V)	17	17
Output voltage min. (V)	0.6	0.6
Output voltage max. (V)	5.5	5.5
Continuous current (A)	15	15
Switch frequency min. (kHz)	200	200
Switch frequency max. (kHz)	1000	1000
Pre-bias operation (yes / no)	Yes	Yes
Internal bias reg. (yes / no)	Yes	Yes
Compensation	Not required	Not required
Enable (yes / no)	Yes	Yes
P <sub>GOOD</sub> (yes / no)	Yes	Yes
Overcurrent protection	Programmable	Programmable
Protection	OVP, OCP, UVP/SCP, OTP, UVLO	OVP, OCP, UVP/SCP, OTP, UVLO
Light load mode	Ultrasonic	Powersave
Peak efficiency (%)	95	95
Package type	PowerPAK MLP32-55G	PowerPAK MLP32-55G
Package size (W, L, H) (mm)	5.0 x 5.0 x 0.85	5.0 x 5.0 x 0.85
Status code	2	2
Product type	microBUCK (step down regulator)	microBUCK (step down regulator)
Applications	Computing, consumer, networking, industrial, healthcare	Computing, consumer, networking, industrial, healthcare

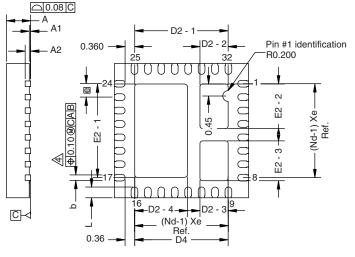
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**Vishay Siliconix** 



### PowerPAK<sup>®</sup> MLP55-32L CASE OUTLINE



Top View

Side View

Bottom View

		MILLIMETERS		INCHES			
DIM	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.80	0.85	0.90	0.031	0.033	0.035	
A1 <sup>(8)</sup>	0.00	-	0.05	0.000	-	0.002	
A2		0.20 REF.			0.008 REF.		
b <sup>(4)</sup>	0.20	0.25	0.30	0.078	0.098	0.011	
D	5.00 BSC				0.196 BSC		
е	0.50 BSC				0.019 BSC		
E		5.00 BSC			0.196 BSC		
L	0.35	0.40	0.45	0.013	0.015	0.017	
N <sup>(3)</sup>		32			32		
Nd <sup>(3)</sup>		8		8			
Ne <sup>(3)</sup>	8				8		
D2 - 1	3.43	3.48	3.53	0.135	0.137	0.139	
D2 - 2	1.00	1.05	1.10	0.039	0.041	0.043	
D2 - 3	1.00	1.05	1.10	0.039	0.041	0.043	
D2 - 4	1.92	1.97	2.02	0.075	0.077	0.079	
E2 - 1	3.43	3.48	3.53	0.135	0.137	0.139	
E2 - 2	1.61	1.66	1.71	0.063	0.065	0.067	
E2 - 3	1.43	1.48	1.53	0.056	0.058	0.060	

Notes

1. Use millimeters as the primary measurement.

2. Dimensioning and tolerances conform to ASME Y14.5M. - 1994.

3. N is the number of terminals.

Nd is the number of terminals in X-direction and Ne is the number of terminals in Y-direction.

A Dimension b applies to plated terminal and is measured between 0.20 mm and 0.25 mm from terminal tip.

 $/ \Delta$  The pin #1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body.

6. Exact shape and size of this feature is optional.

A Package warpage max. 0.08 mm.

8 Applied only for terminals.



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